



The Byte Attic's

Agon light™

Hardware Manual

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What is Agon light™?

- A modern 8-bit microcomputer and microcontroller in one small, low-cost board
- Requires no host PC: Agon light puts out its own video (VGA, various modes, 64 colors), audio (2 identical mono channels), accepts a PS/2 keyboard and has µSD-card storage
- Features a control port with SPI, I²C, 20 distinct GPIOs, a system clock output, as well as power (3.3V and 5V) and ground rails
- Features a separate ACCESS.bus header for e.g. an optional status display
- Aims at the best possible trade-off across performance, cost and flexibility with cutting-edge technology
- There are no FPGAs and no emulation in Agon™: the 'bare wires' are exposed directly to the firmware programmer
- Agon light is powered by USB and runs internally at 3.3V

What is so unique and attractive about it?

- Instant-on, stand-alone, BASIC-programmed* microcontroller: no host PC or sketch compilation required
- Control your whole house from the immediacy of a BASIC prompt! *
- Say goodbye to assembly:
 - C-programmable audio/video coprocessor firmware with freely available tooling
 - C-programmable CPU firmware with freely available tooling
- A hardware canvas for you to make of it your own dream, firmware-customized microcomputer
- A laboratory for computer science experimentation
- The most advanced 8-bit microcomputer to date
- The best balance of cost, performance and programmability
- Agon light is an open-hardware and open-source project, so you get *all* the information about the system

* Requires installation of Quark™ firmware by Dean Belfield



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Agon light™

Technical
overview and
specifications



Architecture and specifications

- Two subsystems:
 - The *processor subsystem*
 - The *terminal subsystem*
- The *processor subsystem* comprises:
 - CPU (eZ80F92 running at 18.432MHz)
 - System memory (512KB, 10ns, parallel SRAM)
 - µSD-card port (as main storage)
 - ZDI port (for programming the firmware of the CPU)
 - Control port (including 20 GPIOs) to control your projects from BASIC*
- The *terminal subsystem* comprises:
 - Audio/video coprocessor (ESP32-PICO-D4 running at 240MHz)
 - Terminal memory (8MB, 133MHz, serial pSRAM)
 - Keyboard port (PS/2)
 - VGA port (various modes, 64 colors)
 - Audio jack (2x mono)
 - USB 2.0 port (for power and programming the ESP32's firmware)
- The two subsystems communicate with each other via full-duplex high-speed serial link (1.152 megabits per second), featuring flow control

* Requires installation of Quark™ firmware by Dean Belfield

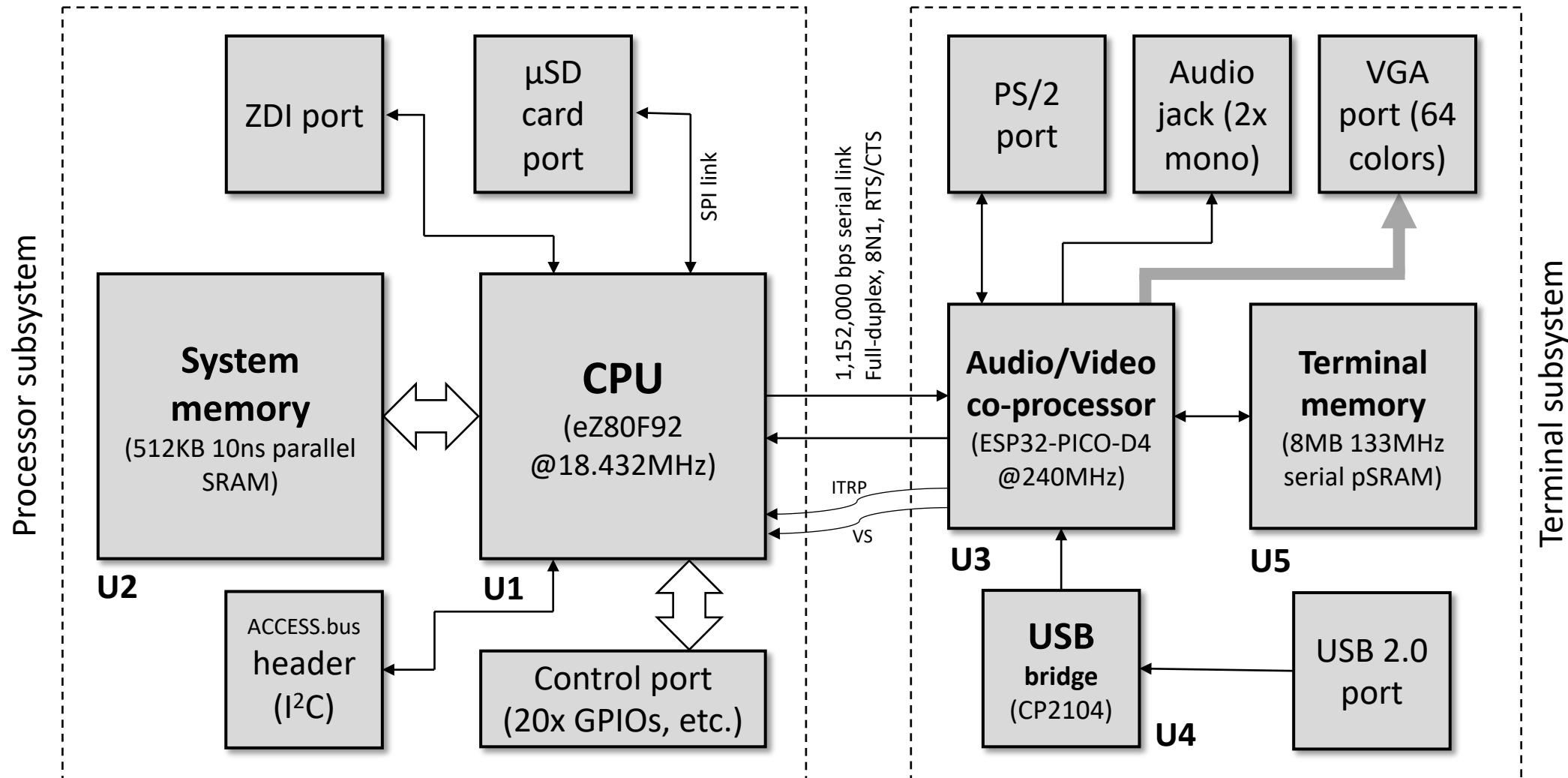
Theory of operation

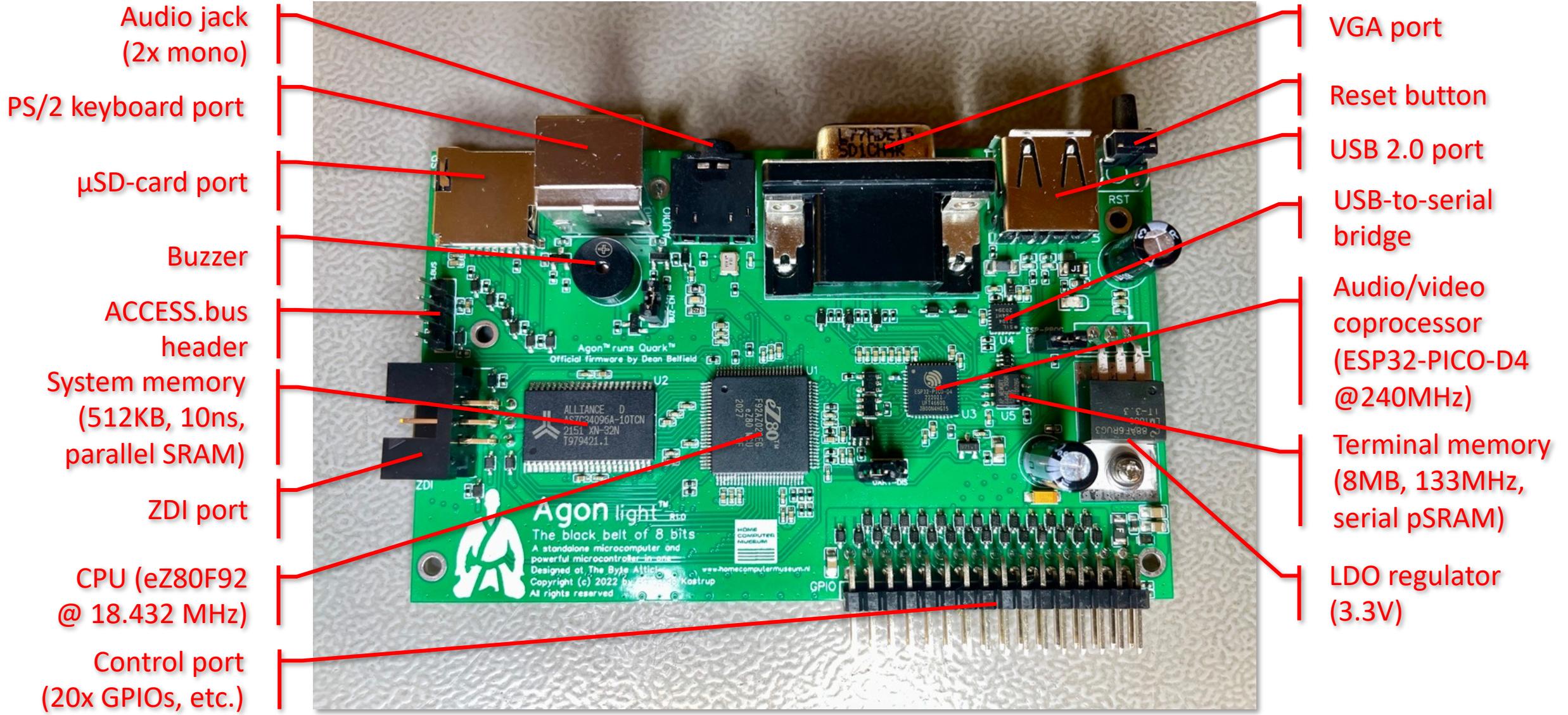
- The *terminal subsystem*:
 - Reads out the (PS/2) keyboard and sends the corresponding keypress tokens to the CPU via a high-speed serial link
 - Generates the screen based on display-list commands issued by the CPU and sent to the ESP32 via a high-speed serial link
 - Produces the VGA & audio signals
 - Supports the FabGL™ library
 - Sends the vertical synch signal (**VS**, from pin 21/IO15) both to the VGA port *and the CPU*
 - Sends a general-purpose, firmware-programmable signal (**ITRP**, from pin 28/SD2) to the CPU
- The *processor subsystem*:
 - Runs the BIOS and BASIC interpreter*
 - Executes application code
 - Drives the GPIOs based on the application code
 - Drives the *terminal subsystem* by issuing display-list and audio-related commands to the ESP32 via a high-speed serial link
 - Manages storage (μ SD-card)
 - The eZ80F92 CPU receives the vertical synch (**VS**, in pin 89/PB1/T1_IN) and a general-purpose firmware-programmable signal (**ITRP**, in pin 88/PB0/T0_IN) from the ESP32, both of which can be used by the eZ80F92 as interrupts

* Requires installation of Quark™ firmware
by Dean Belfield

System diagram

↔ Serial link
↔ Parallel link



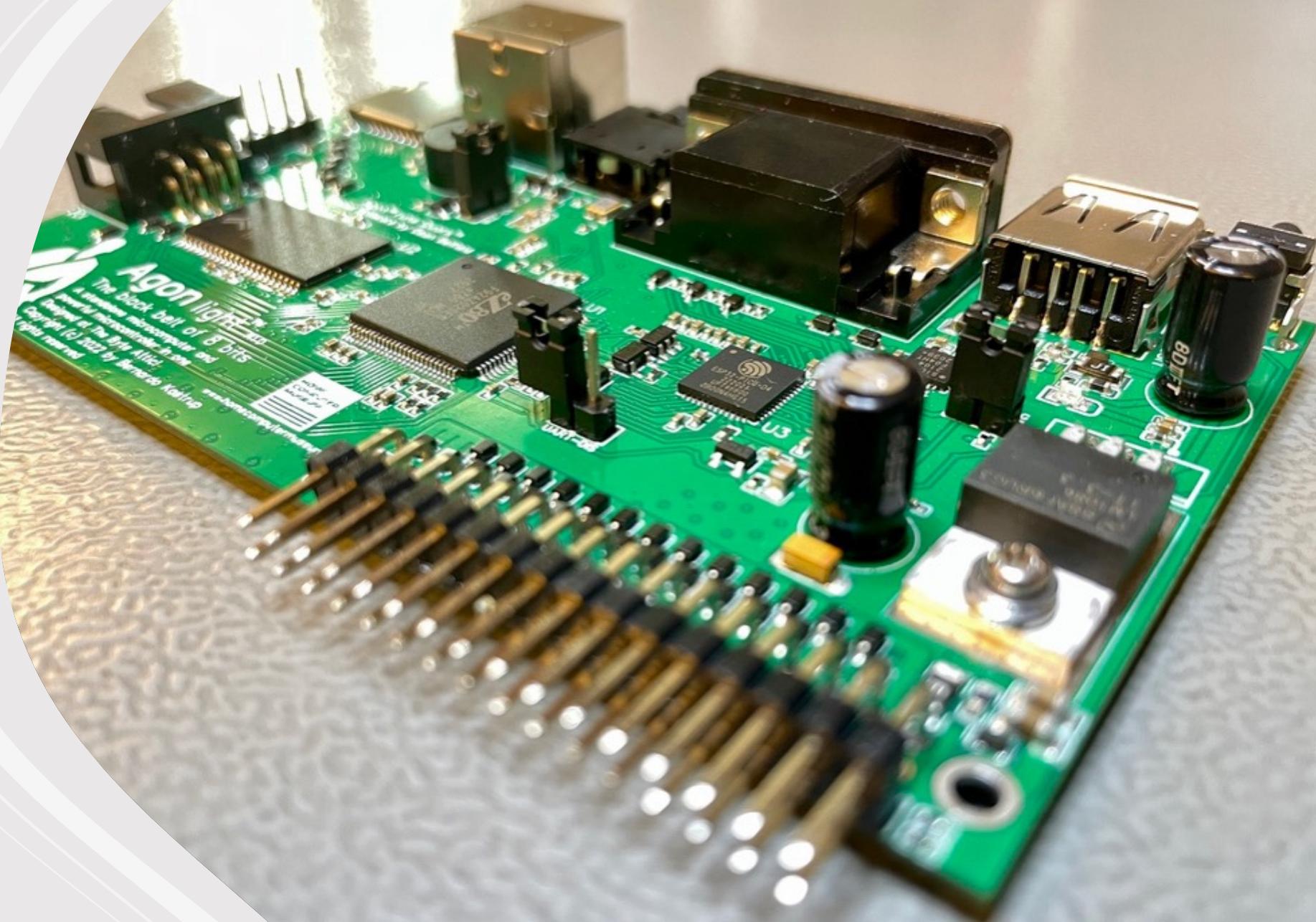




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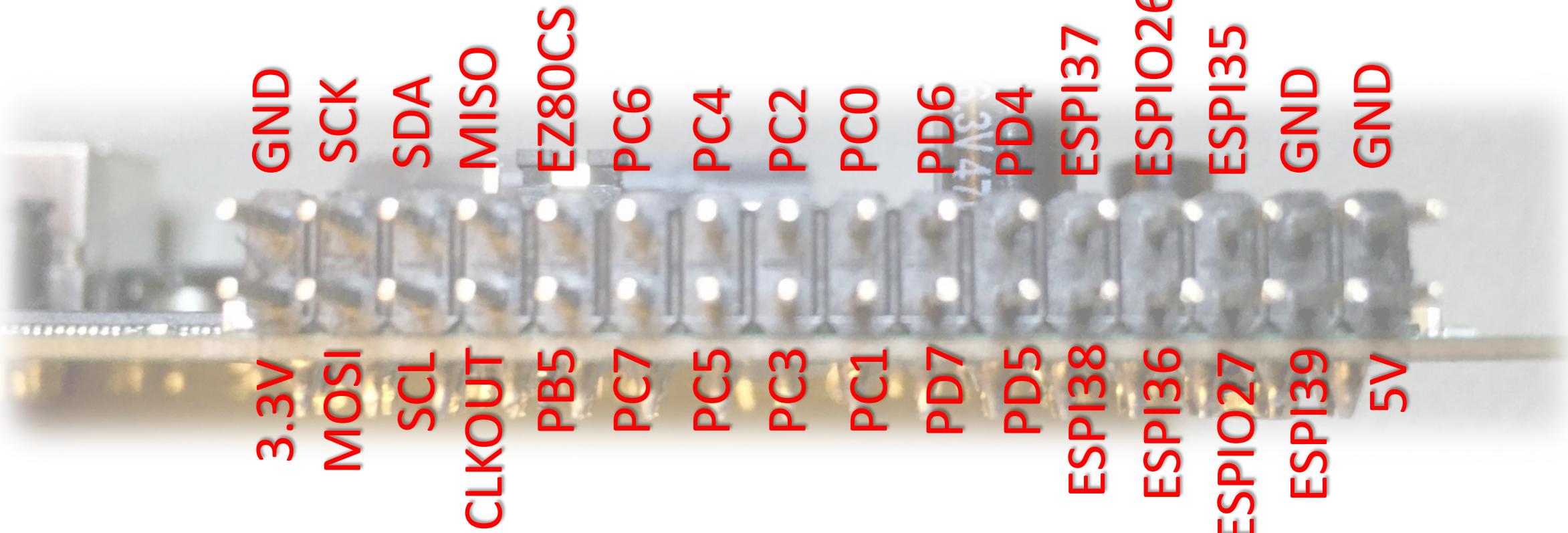
User's
guide



Control port signal descriptions

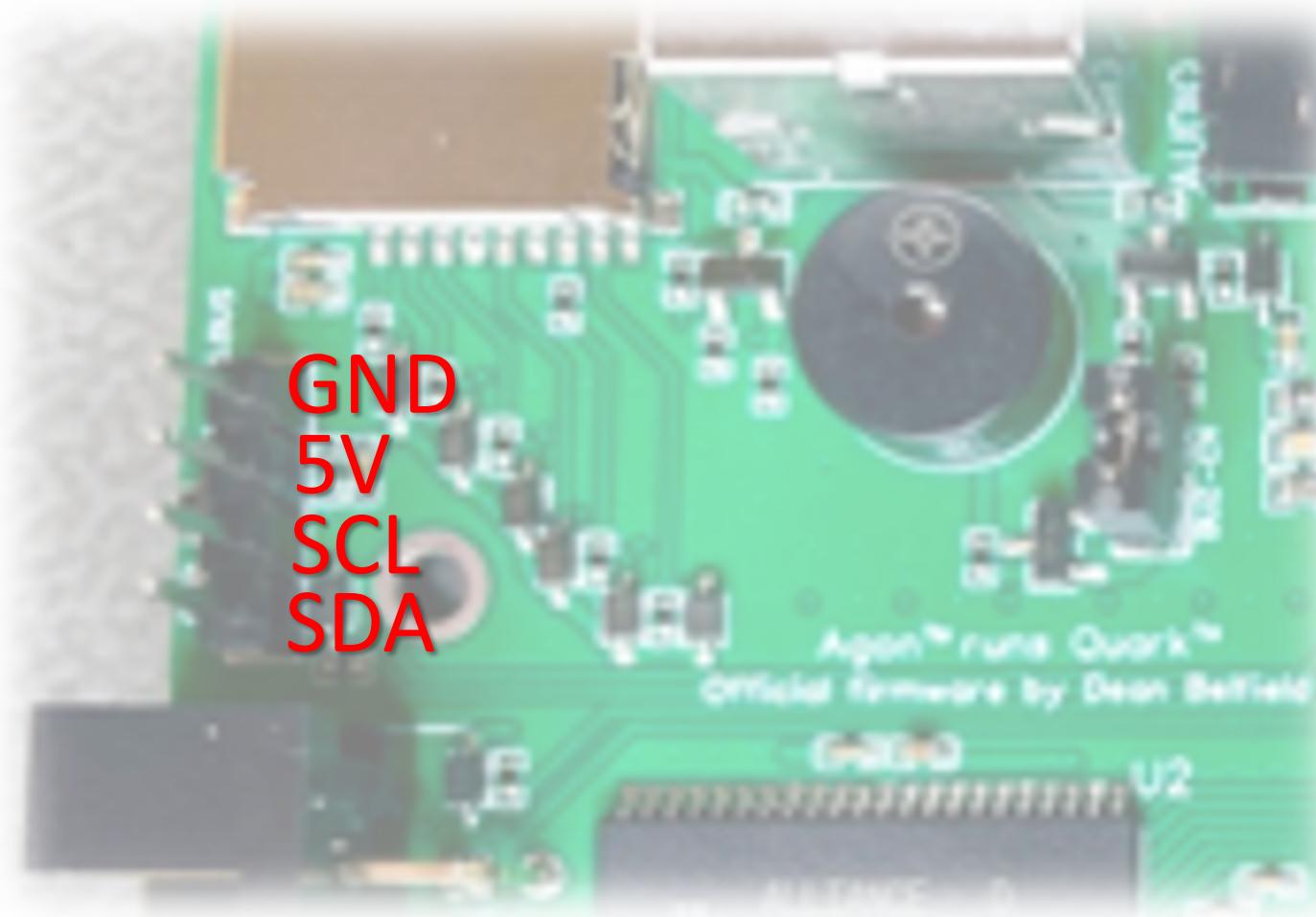
- **CLKOUT**: System clock (18.432MHz) buffered by the eZ80F92 CPU (PHI)
- ESP32-PICO-D4 *bidirectional* GPIOs:
(see datasheet for clarifications)
 - **ESPIO26** (pin 15, IO26) and **ESPIO27** (pin 16, IO27), both pulled up by 22KΩ resistors
- ESP32-PICO-D4 GP *inputs*:
(see datasheet for clarifications)
 - **ESPI39** (SENSOR_VP), **ESPI38** (SENSOR_CAPP), **ESPI37** (SENSOR_CAPN), **ESPI36** (SENSOR_VN), **ESPI35** (IO35)
- **MOSI** (pin 95, PB7), **SCK** (pin 91, PB3), **MISO** (pin 94, PB6), **EZ80CS** (pin 90, PB2/!SS): SPI signals of the eZ80F92
- **SDL**, **SCA**: I²C signals of the eZ80F92
- eZ80F92 *multi-functional, bidirectional* GPIOs:
(see datasheet for clarifications)
 - **PB5/T5_OUT**
 - **PC0/TxD1**, **PC1/RxD1**, **PC2/!RTS1**, **PC3/!CTS1**, **PC4/!DTR1**, **PC5/!DSR1**, **PC6/!DCD1**, **PC7/!RI1**
 - **PD4/!DTR0**, **PD5/!DSR0**, **PD6/!DCD0**, **PD7/!RI0**

Control port pinout



See schematics and eZ80F92 and ESP32-PICO-D4
datasheets for more comprehensive signal descriptions

ACCESS.bus header pinout



Pinout of serial link between CPU and ESP32

- On the *eZ80F92*'s side:
 - Pin 68 (**PD0/TXD0/IR_TXD**) is the transmitter
 - Pin 69 (**PD1/RXD0/IR_RXD**) is the receiver
 - Pin 70 (**PD2/!RTS0**) is RTS (signal '*eZ80RTS*' in the schematics)
 - Pin 71 (**PD3/!CTS0**) is CTS (signal '*eZ80CTS*' in the schematics)
- On the *ESP32-PICO-D4*'s side:
 - Pin 10 (**IO34**) is the receiver (connected to signal '*eZ80TxD*' in the schematics)
 - Pin 22 (**IO2**) is the transmitter (connected to signal '*eZ80RxD*' in the schematics)
 - Pin 17 (**IO14**) is CTS (connected to signal '*eZ80RTS*' in the schematics)
 - Pin 20 (**IO13**) is RTS (connected to signal '*eZ80CTS*' in the schematics)

Recommended configuration of serial link between CPU and ESP32

Channel: full duplex, asynchronous

Baud rate: 1,152,000 bits per second

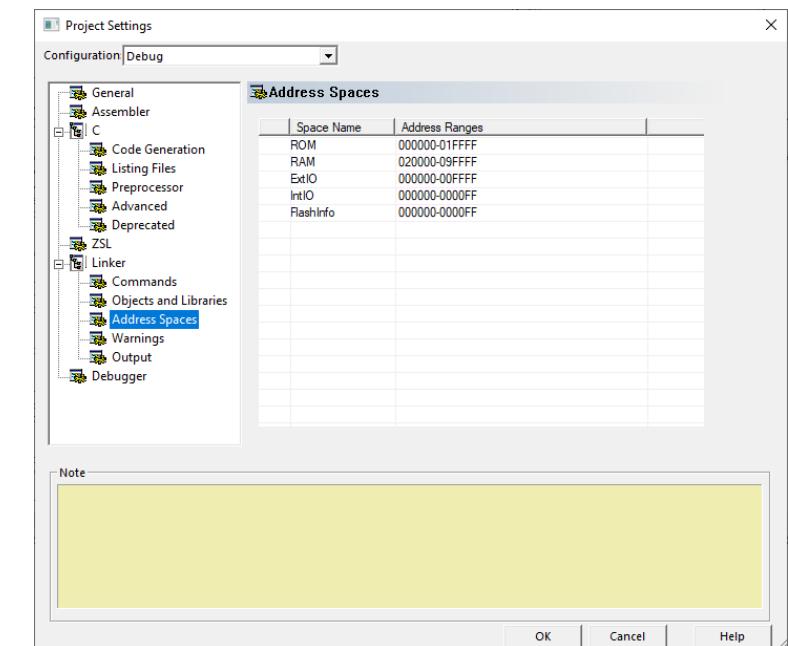
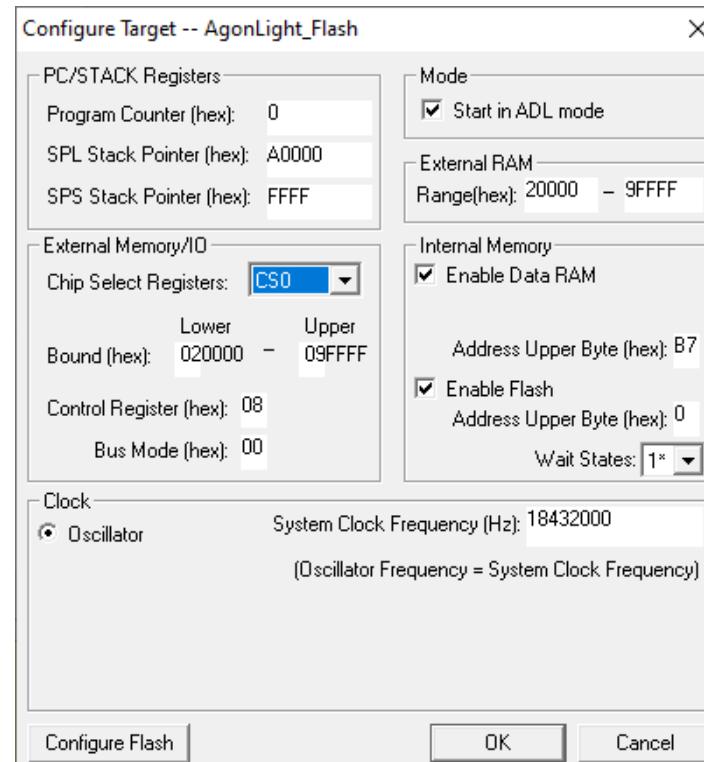
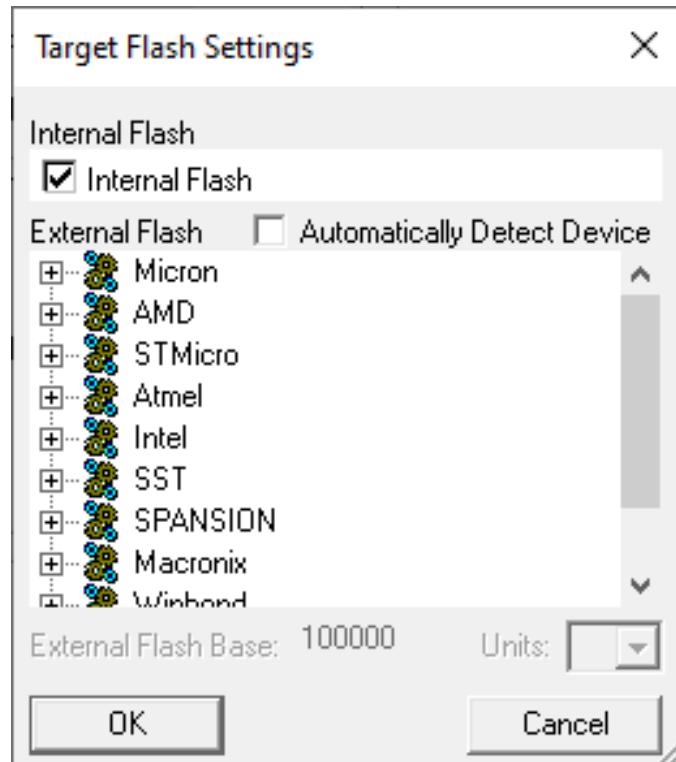
Signal structure: 1 start bit, 8 data bits, 1 stop bit,
no parity bit (8N1)

Flow control: CTS/RTS

Other possible baud rates are: 115200, 128000, 144000, 192000, 230400, 288000, 384000, and 576000 bps

Developing firmware for the eZ80F92

- Use the freely-available Zilog ZDS-II™ IDE, downloadable from:
https://www.zilog.com/index.php?option=com_zcm&task=view&soft_id=54&Itemid=74
- Documentation is provided in the Agon light Github repository, in the directory /Third party documentation
- Configure your project as per the figures below (CS1, CS2 and CS3 are *not* used in Agon light, so their settings don't matter)



Required programming/debugging USB smart capable

- To upload firmware into the eZ80F92 CPU, from within the ZDS-II IDE, you will need a Zilog opto-isolated *USB Smart Cable*

- Zilog product numbers:

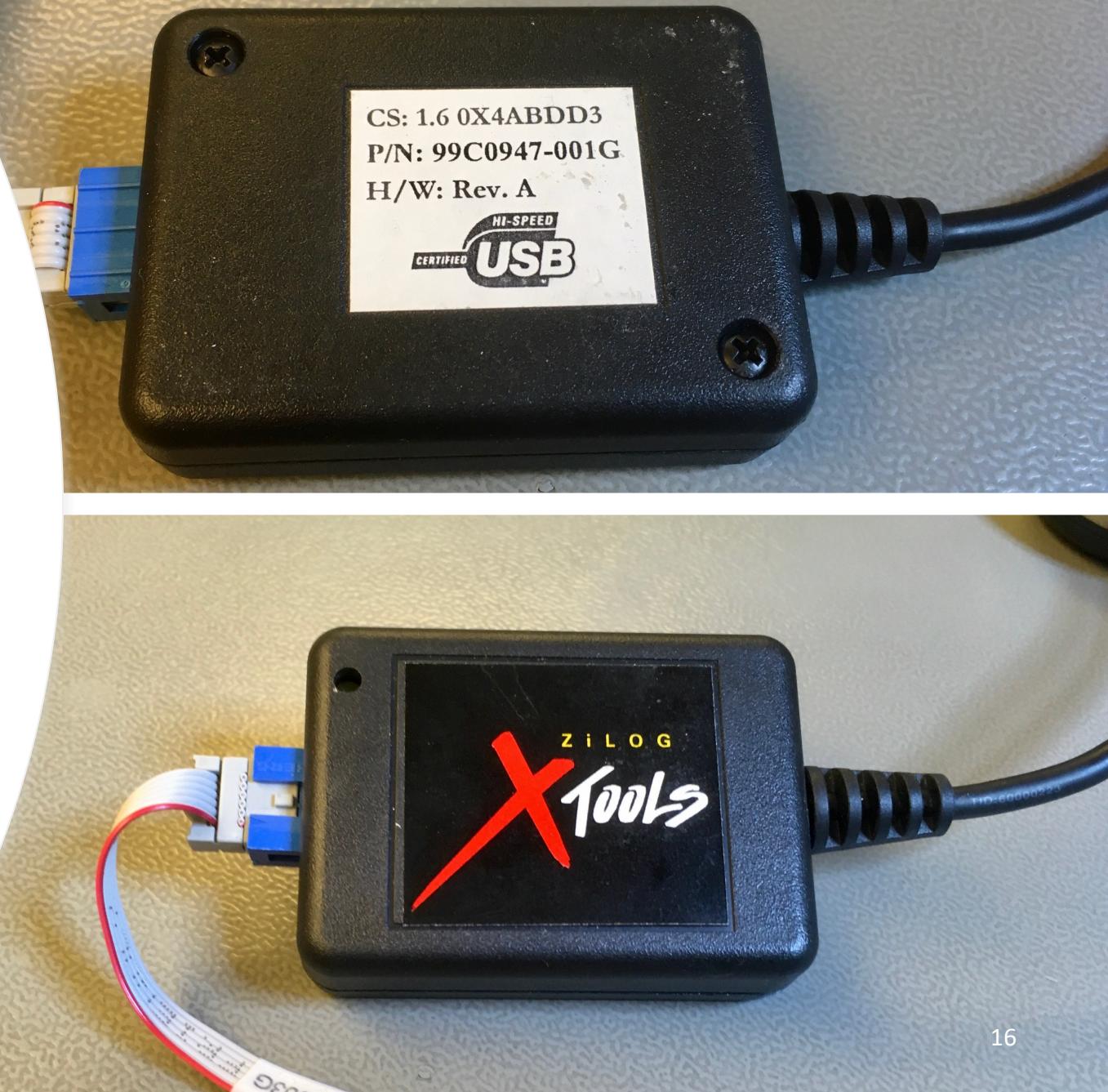
ZUSBSC00100ZACG (discontinued)

ZUSBASC0200ZACG (current; requires v5.3.5 or later of Zilog's **ZDS-II IDE**)

ATTENTION: the cable with product number ZUSBESC0200ZACG is **NOT** suitable for Agon light™!

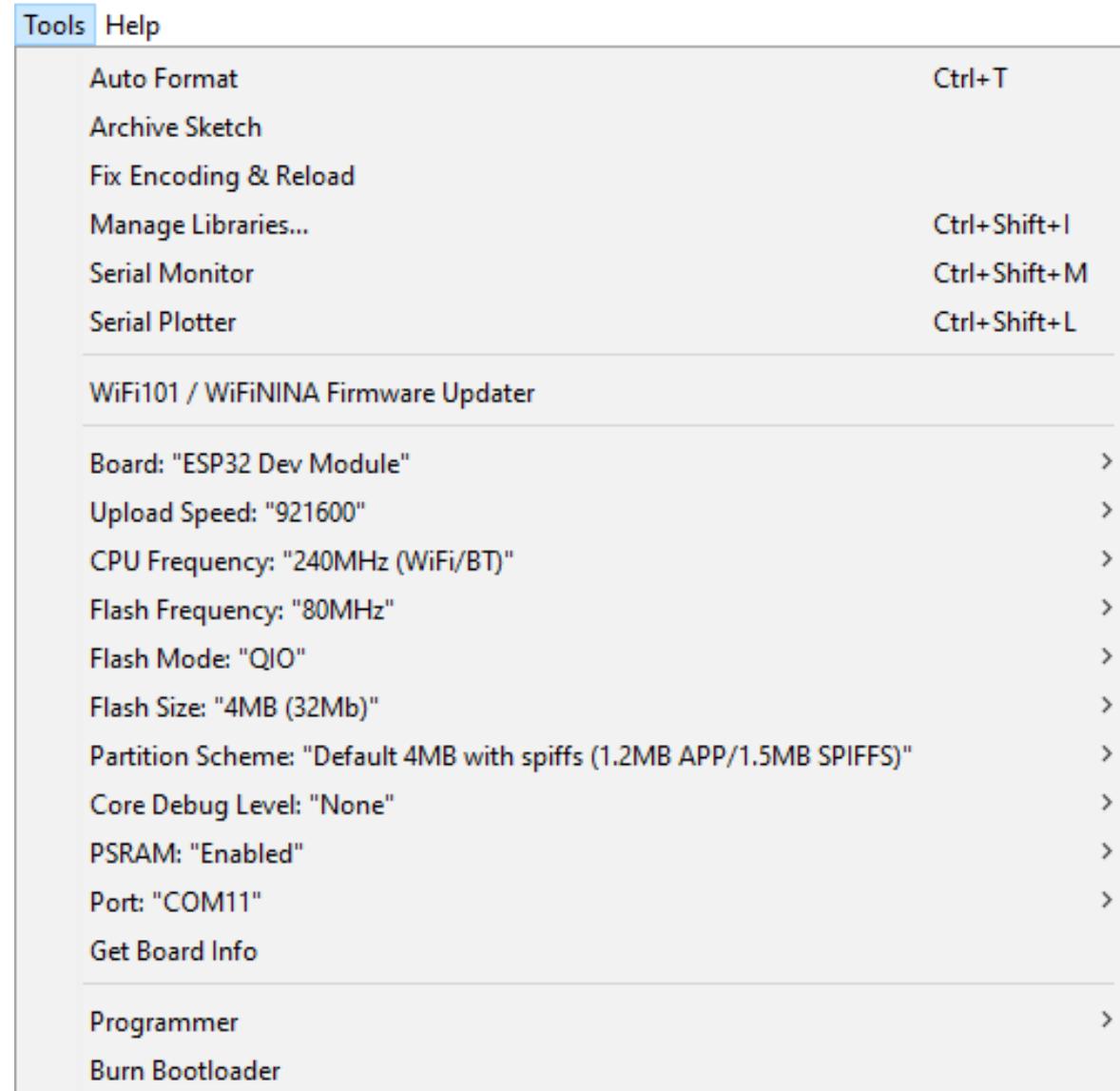
- This cable is only needed for programming the eZ80 *for the first time*. If you bought a pre-programmed Agon light™, you can update the firmware *without* this cable, by using the software utility here:

<https://github.com/envenomator/agon-flash>



Developing firmware for the ESP32-PICO-D4

- Use the freely-available Arduino™ IDE
- Install the FabGL™ library as per instructions available online
 - Link to the FabGL library: <http://www.fabgl.org/index.html>
 - Link to installation tutorial: <https://youtu.be/8OTaPQISTas>
- The figure to the right illustrates a suitable configuration for loading an Arduino sketch into the ESP32
 - Change the port number to the one active in your case



Power supply and signal level considerations

- Agon light can be powered (5V) *either* from its USB port *or* from the 5V pin in its control port
- If Agon light is powered from the USB port, then the 5V pin in the control port can be used to power an external circuit connected to Agon light
- Similarly, the 3.3V pin in the control port can be used to power an external circuit, *but it cannot be used to power Agon light*
- The on-board LDO regulator can provide up to 1.5A of current at 3.3V
 - This is the maximum *total* current for Agon light's internal use *and* devices powered from the 3.3V pin in the control port
 - It assumes that the USB device powering Agon light can deliver 1.5A; otherwise, that device becomes the bottleneck
- All GPIO/I²C/SPI logic signals on the control and ACCESS.bus ports are referenced to 3.3V and, therefore, are *not* TTL-level
 - You must use (two-way) level-shifters if you plan to integrate those signals with external circuitry running at 5V-level
- The GPIO/I²C/SPI logic signals on the control and ACCESS.bus ports are NOT buffered
 - Those signals have the current and fanout limitations described in the eZ80F92 and ESP32-PICO-D4 datasheets
 - It is recommended that you buffer those signals before driving external circuits with them, particularly for larger fanouts
 - If you use an unbuffered signal to drive an external LED, a 1KΩ current-limiting resistor, in series with the LED, is (highly) recommended

Power through USB

- For powering Agon light™ alone, a USB 2.0 cable with *USB A connectors on both ends* will suffice (it will deliver up to 500mA at 5V)
- For powering Agon light™ *and* another circuit attached to Agon light's control port, a USB 3.0 cable with *USB A connectors on both ends* is recommended (it will deliver close to 1A at 5V)

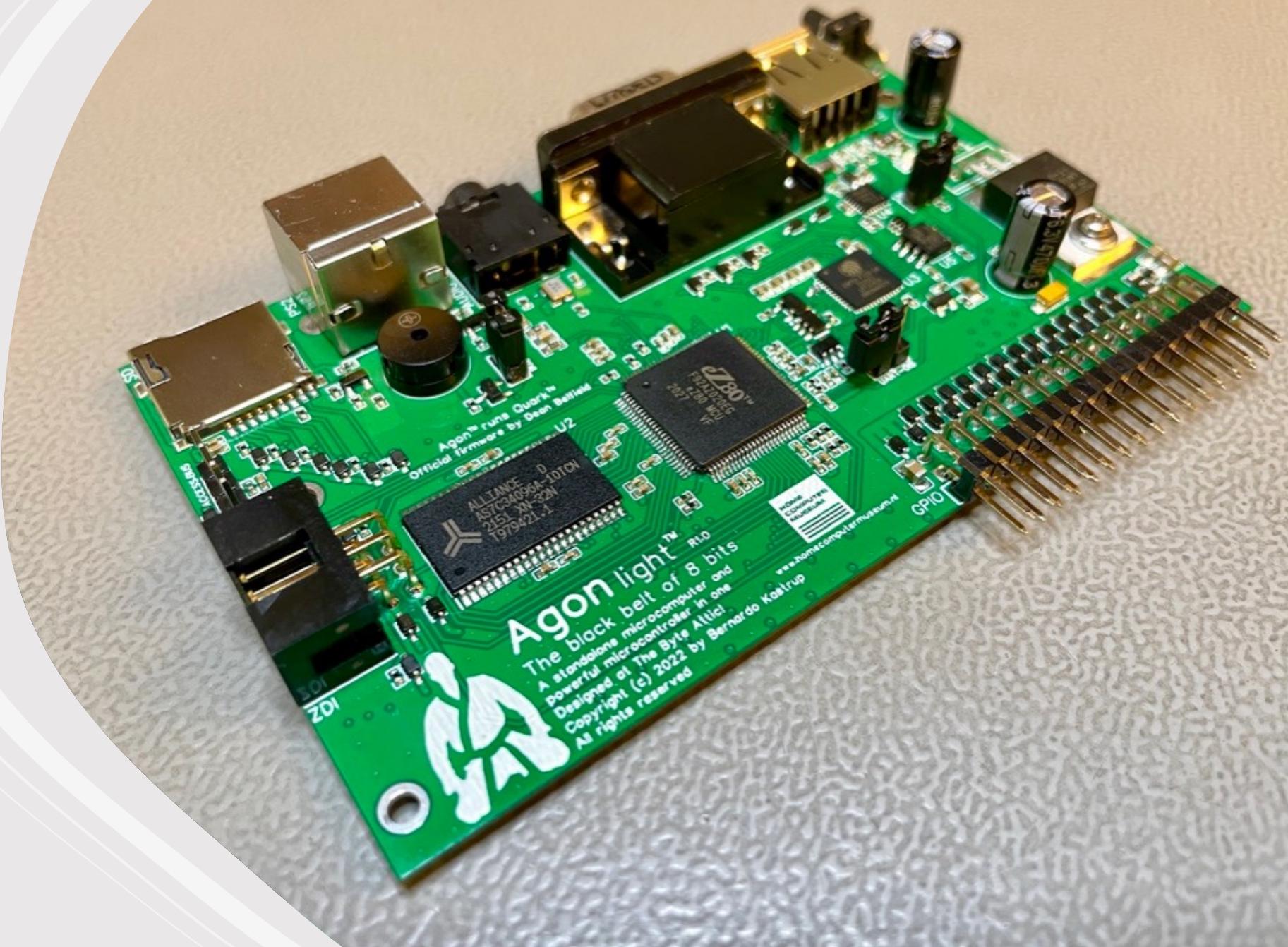




The Byte Attic's

Agon light™

Assembly
guide

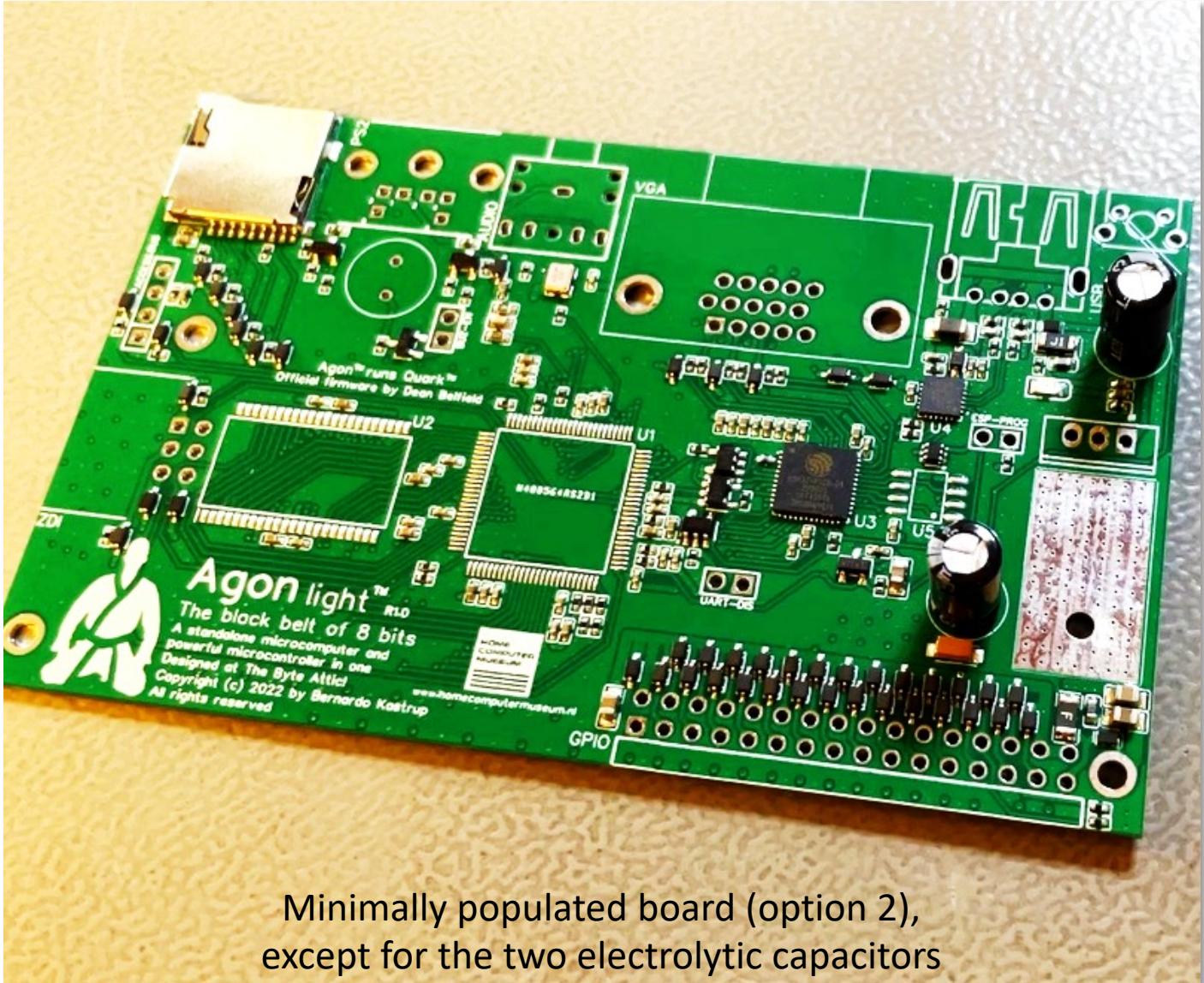


Assembly options

- There are four options:
 1. You buy the bare PCB and fully populate it yourself (requires a stencil and reflow oven)
 2. You buy a PCB minimally populated with the small parts and the two QFN ICs (U3 and U4), which are hard to solder by hand
 3. You buy a PCB with all SMD parts already populated from factory, only the through-hole parts still needing to be soldered
 4. You buy a fully-populated board, so you need not do any soldering yourself
- Options (1), (3) and (4) will not be discussed further: if you choose option (1) you know what you are doing, option (3) is easy enough, and option (4) requires nothing of you
- Option (2) requires though-hole and fine-pitch QFP drag-soldering. Here are the instructions for doing it properly:
<https://youtu.be/k9TF2ZCngoE>
- Reasons for choosing option (2): PCB makers charge a premium (usually 50% of the parts' costs) for procuring parts for you, and there are multiple import fees involved. It's cheaper (and better, if you know how to do it) to buy and populate the most expensive parts (U1, U2 and U5) yourself, especially if you are building Agon light to sell it commercially

Manufacturing files

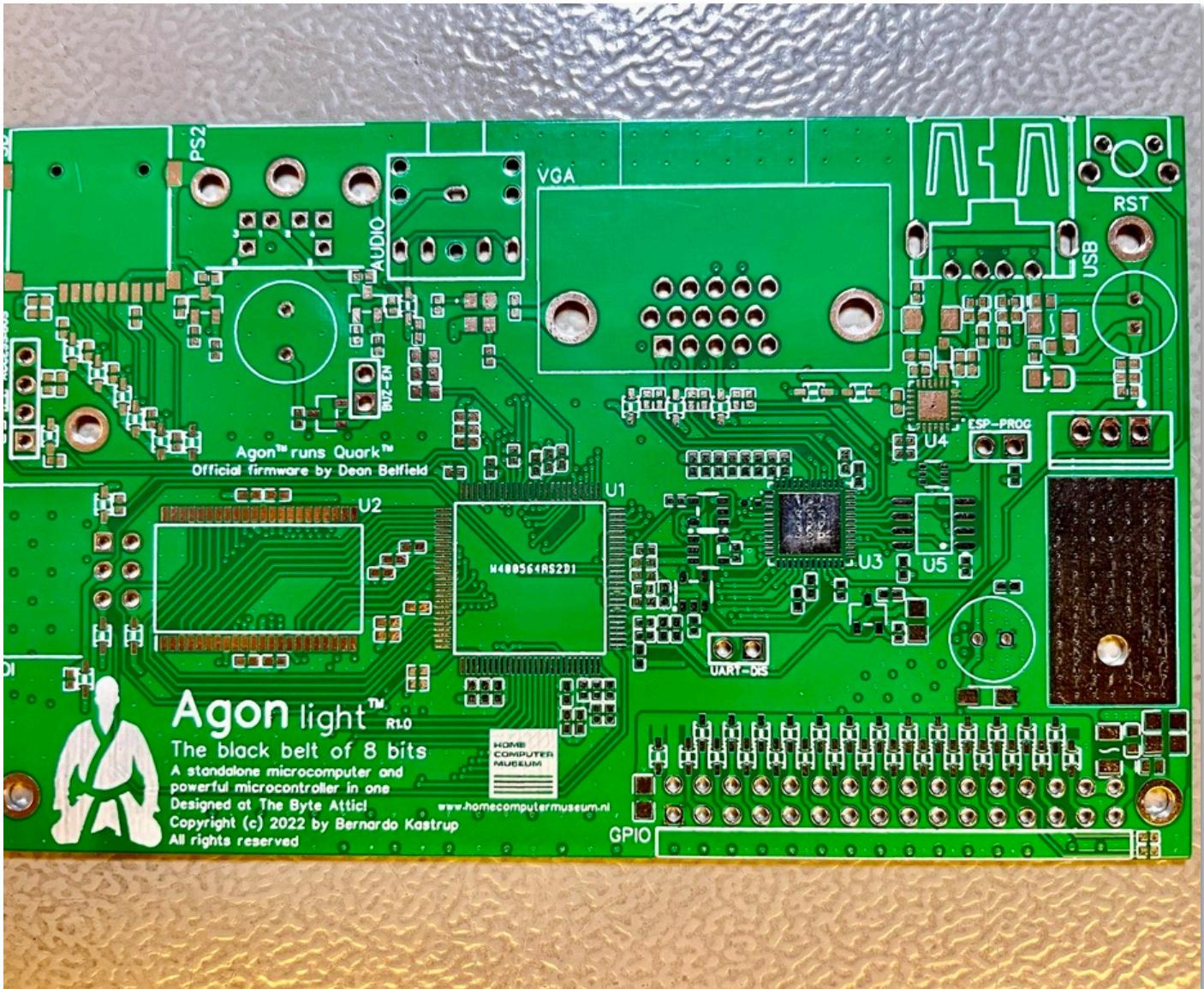
- All files are available in the `/Manufacturing` directory of Agon light's Github repository at:
<https://github.com/TheByteAttic/AgonLight>
- For option (4), send the following files to your PCB manufacturer, next to the Gerber file (`Gerber_PCB_AgonLight_R1.0.zip`):
 - `PickAndPlace_PCB_AgonLight_R1.0.csv`
 - `BOM_PCB_AgonLight_R1.0.csv`
- For option (3), send these files:
 - `PickAndPlace_PCB_AgonLight_R1.0_NoTHT.csv`
 - `BOM_PCB_AgonLight_R1.0_NoTHT.csv`
- For option (2), send these:
 - `PickAndPlace_PCB_AgonLight_R1.0_MINIMAL.csv`
 - `BOM_PCB_AgonLight_R1.0_MINIMAL.csv`



Minimally populated board (option 2), except for the two electrolytic capacitors

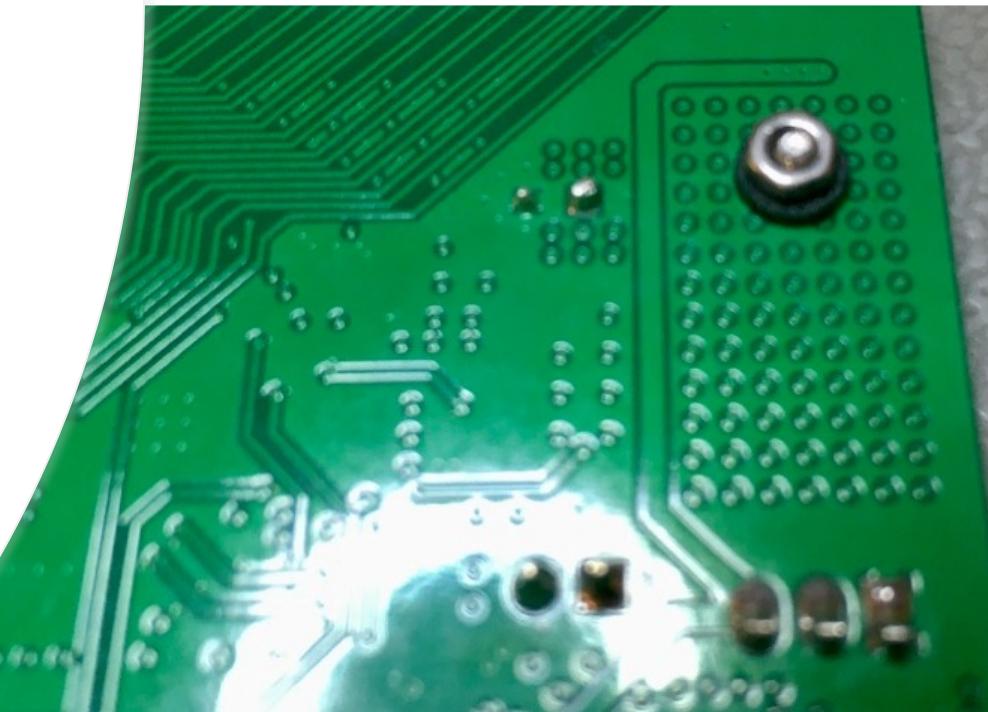
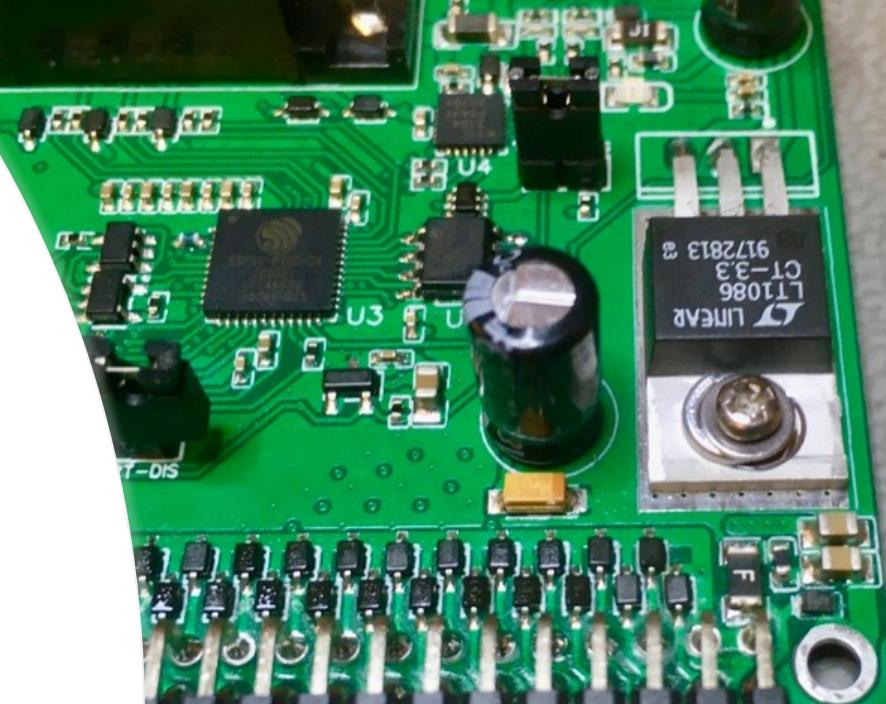
PCB layer stack

- Agon light's PCB has four layers:
 - Two signal layers (top and bottom)
 - Two inner planes (GND and 3.3V)
- The stack is as follows:
 - *TopLayer* (signals + 3.3V copper fill)
 - *Inner1* (GND plane)
 - *Inner2* (3.3V plane)
 - *BottomLayer* (signals + GND copper fill)
- Agon light has tiny VIAs: **0.4mm** diameter with **0.205mm** drill holes, so choose a compatible process with your manufacturer
- Total PCB thickness of **0.8mm** is recommended, so to improve signal integrity

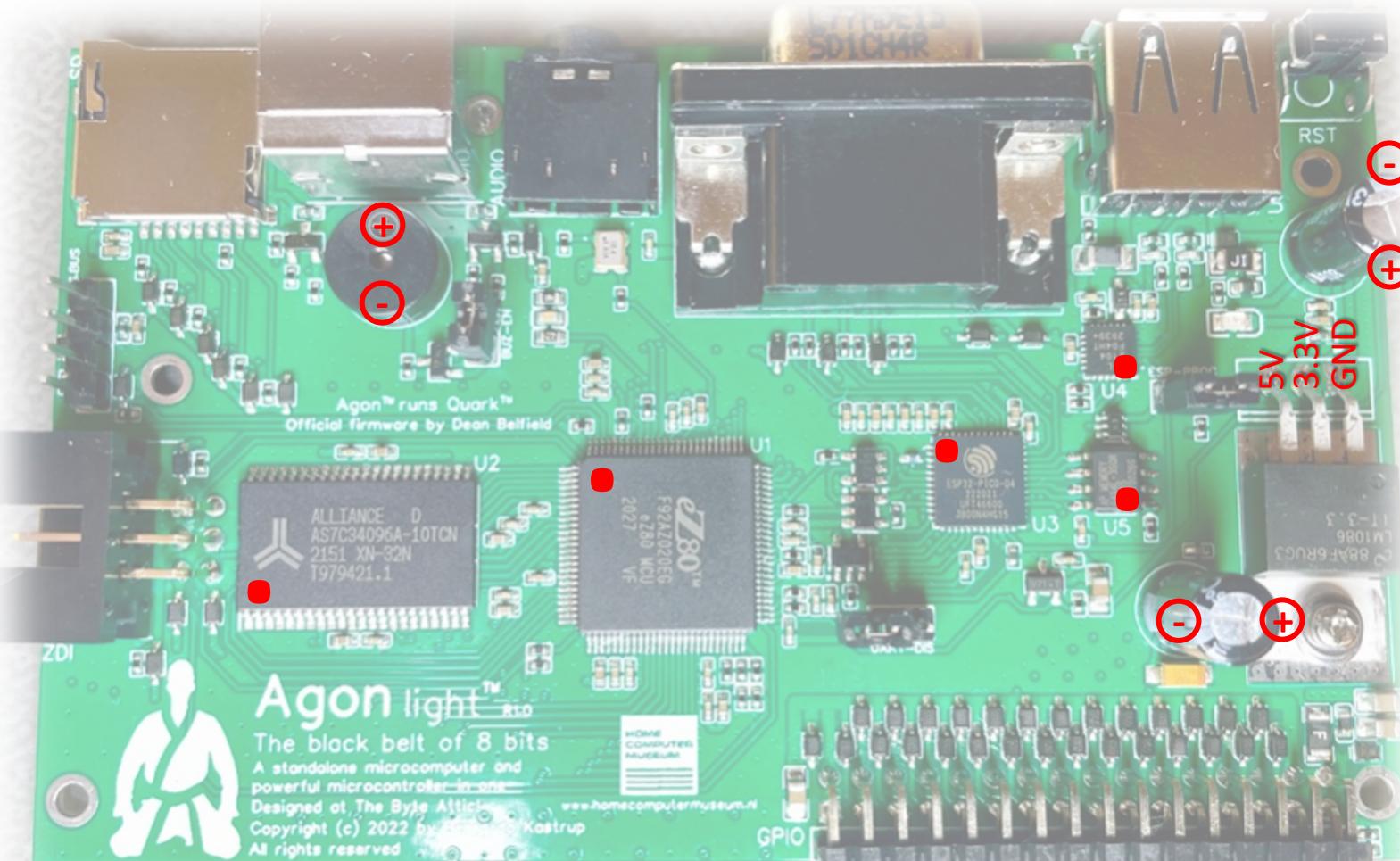


Mounting the LDO regulator

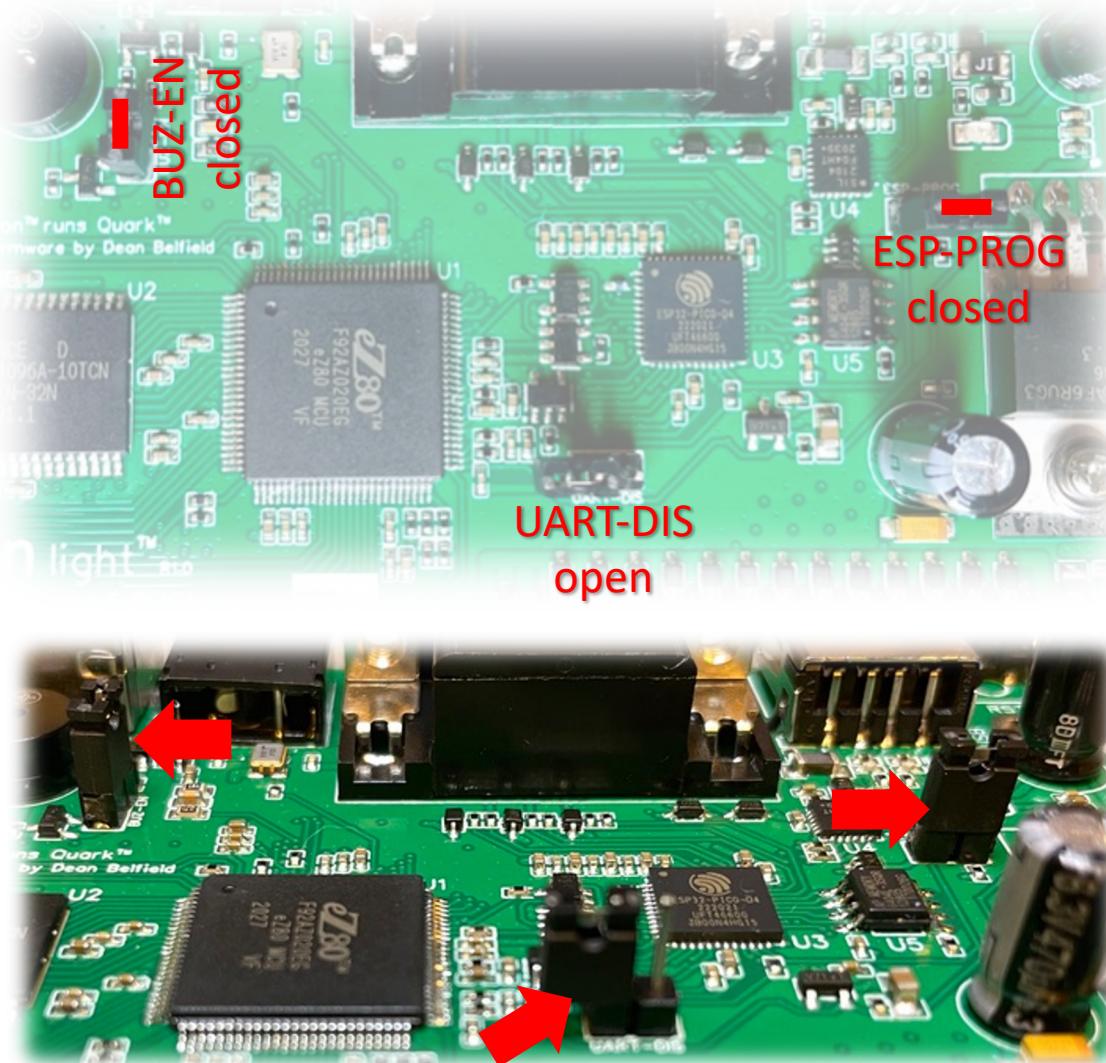
- Agon light's 3.3V V_{cc} rail is provided by a Low-DropOut (LDO) linear regulator
- The regulator must be mounted flush against the corresponding exposed metal area on the top of the PCB (see top-right photo)
- The regulator's tab (chassis) is at 3.3V, as is the exposed copper area on which it is to be mounted
- Use *no thermal paste or insulating spacers*; simply clean the tab and the exposed metal area with IPA before mounting
- Affix the regulator with a 2mm-diameter bolt, a regular and a lock washer on the top, and a nylon (or other dielectric material) washer and nut at the back (see bottom-right photo)
- The nylon washer is important to insulate the back of the board (which is copper-filled with GND) from the bolt-nut combination, which will be at 3.3V
 - Using a metal washer on the back side increases the risk of a short-circuit if the solder mask fails



Part orientations



Default settings for the jumpers

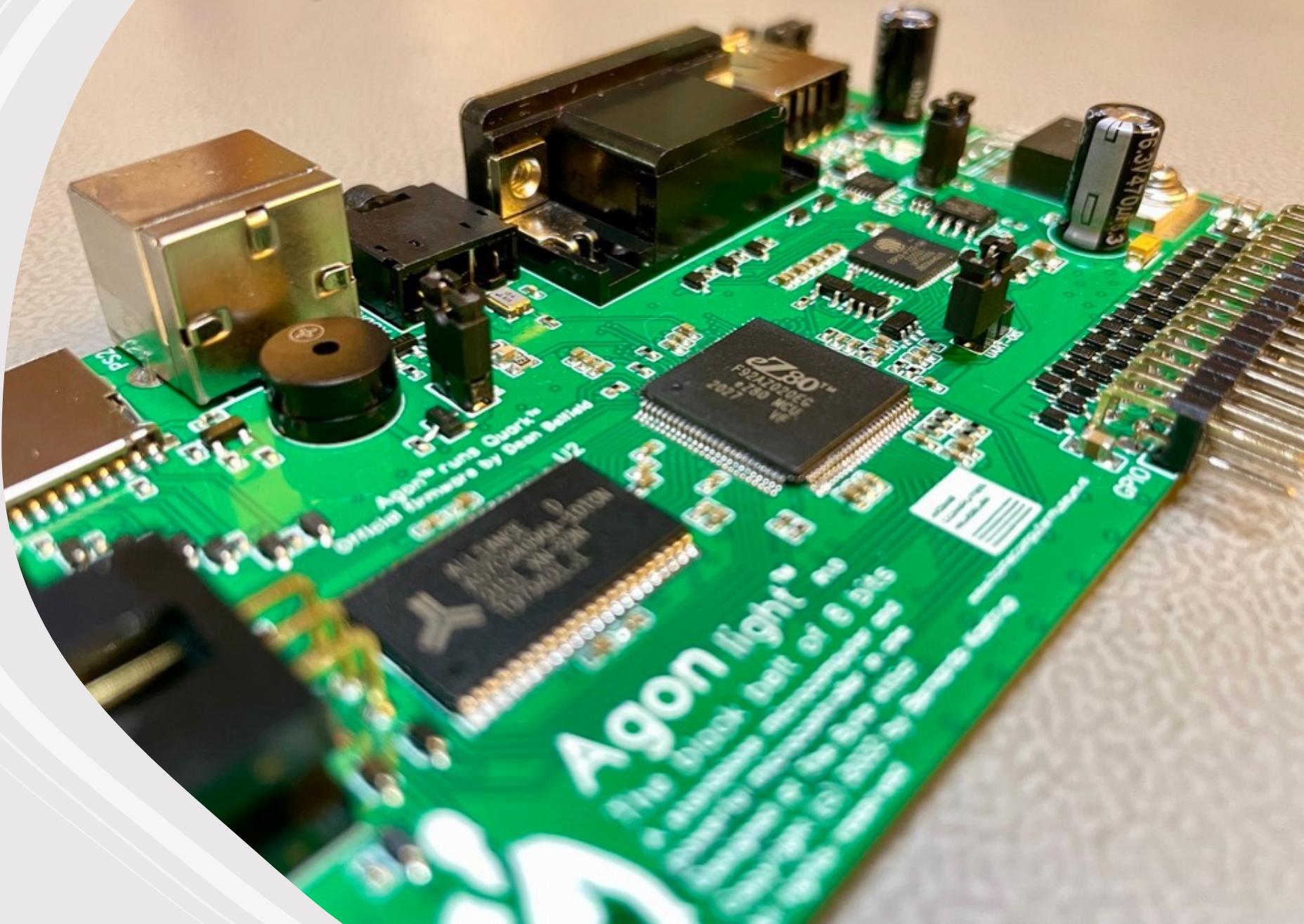


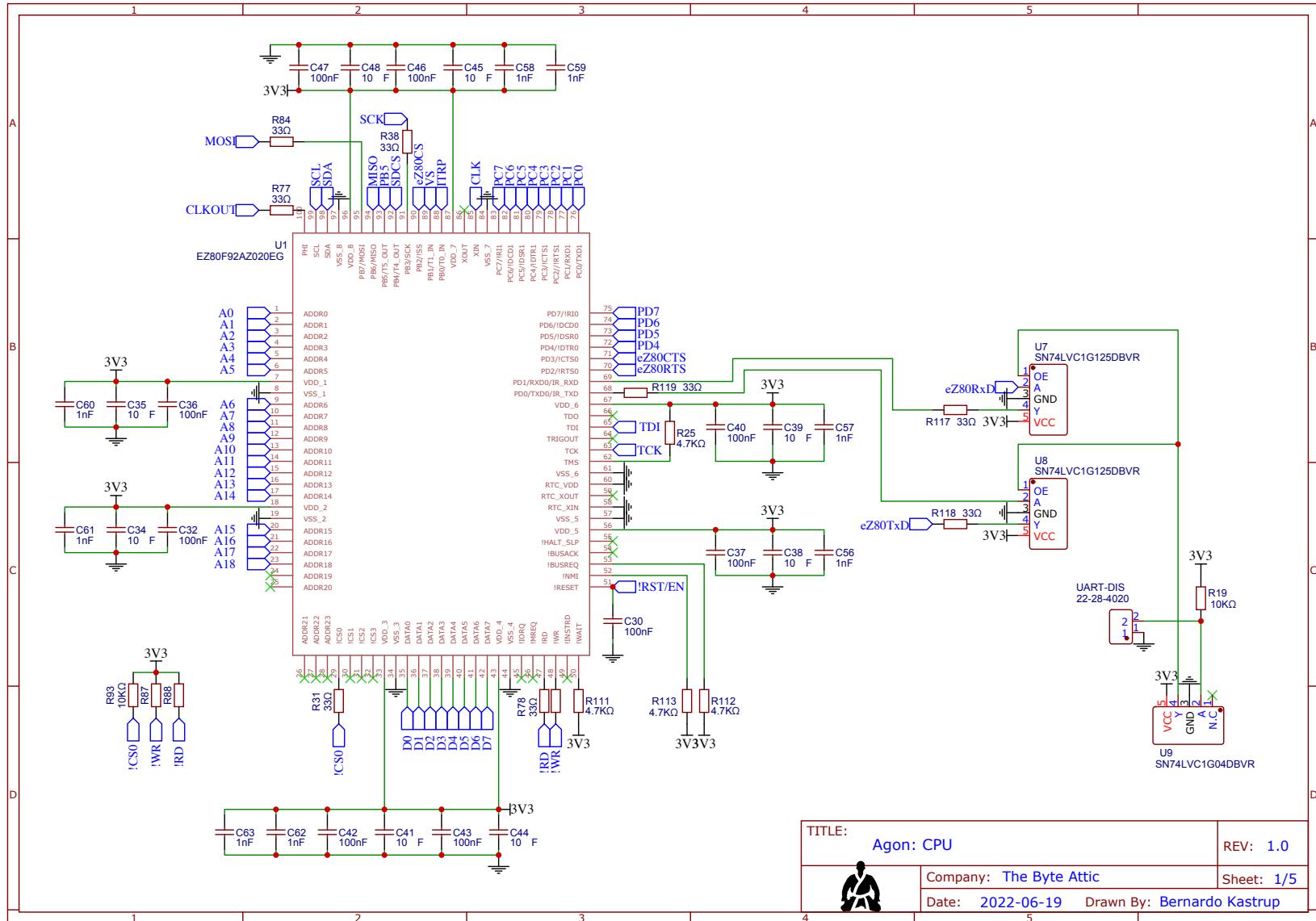
When to change jumper settings

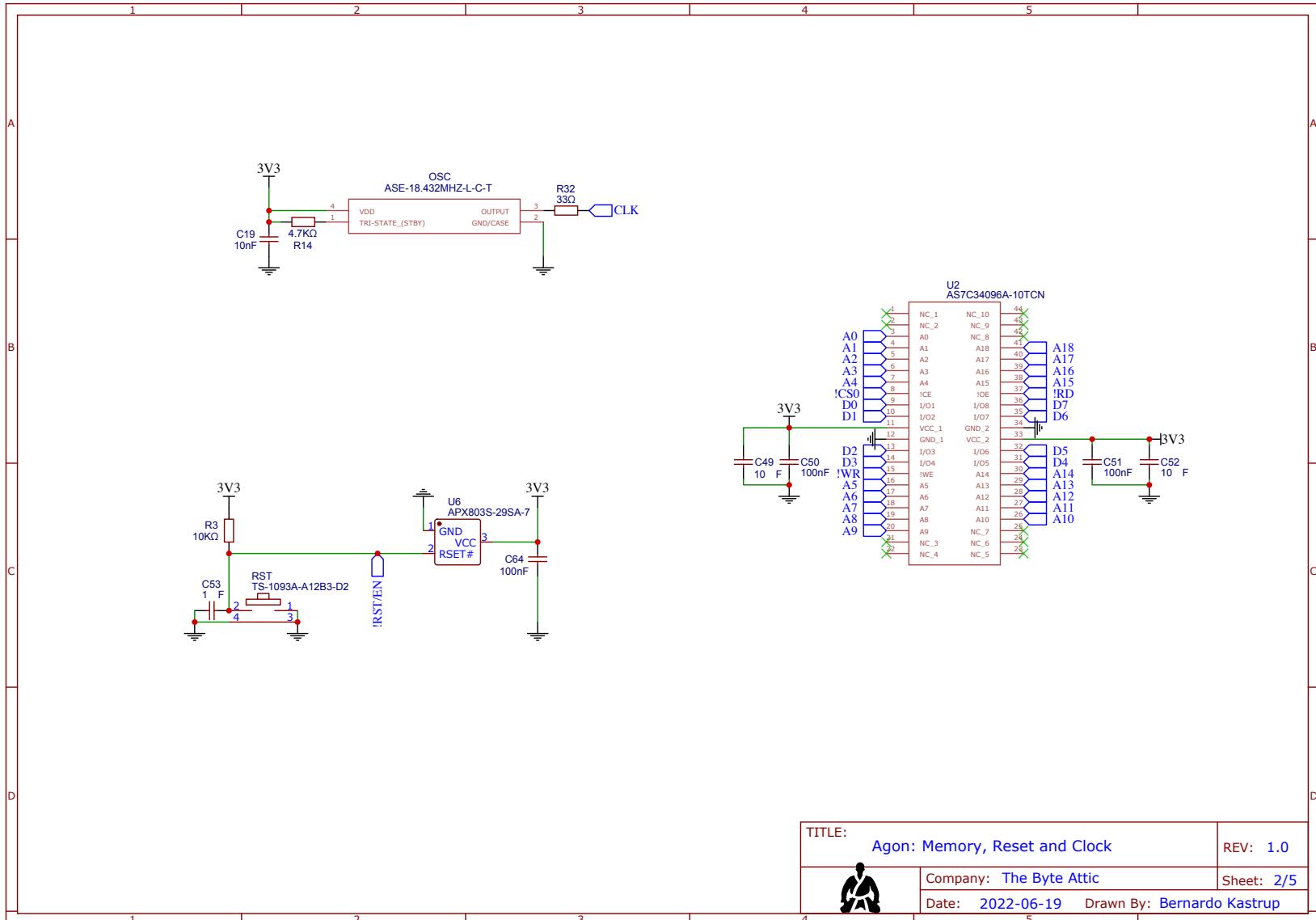
- Agon light should operate normally during both firmware programming and application execution with the default jumper settings (see previous page), but the ESP32 is known to be a sensitive device
 - Therefore, Agon light has built-in resources to deal with that sensitivity
- If the ESP32 goes into programming mode during execution, remove the jumper ‘ESP-PROG’ after programming (remember to place it back before reprogramming the ESP32)
- If you fail to program the ESP32, place the jumper ‘UART-DIS’ during programming (remember to remove it after programming, or Agon light will not operate properly)
- The buzzer produces sounds if speakers are not connected. If those sounds bother you, you can disable the buzzer by removing the jumper ‘BUZ-EN’

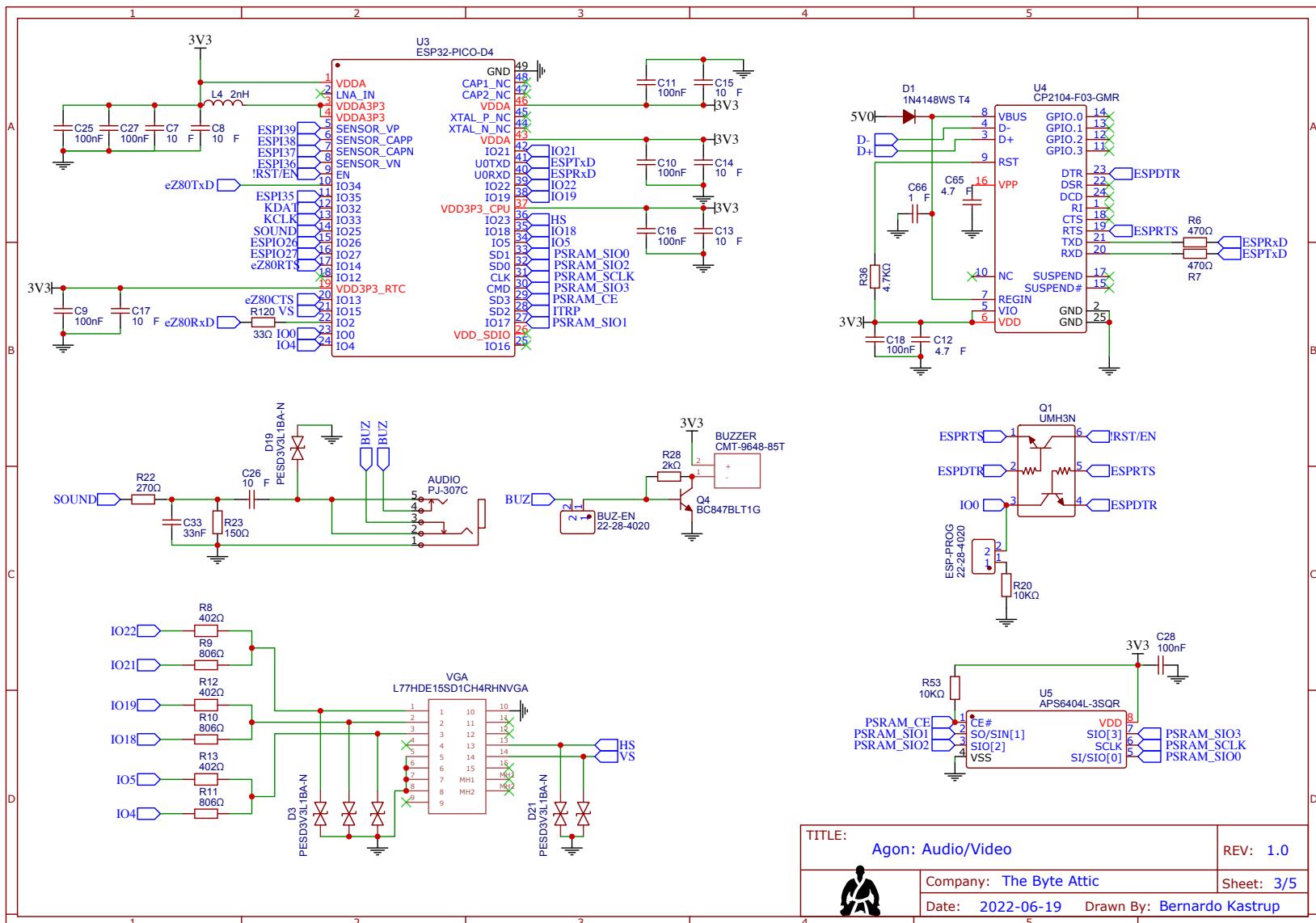


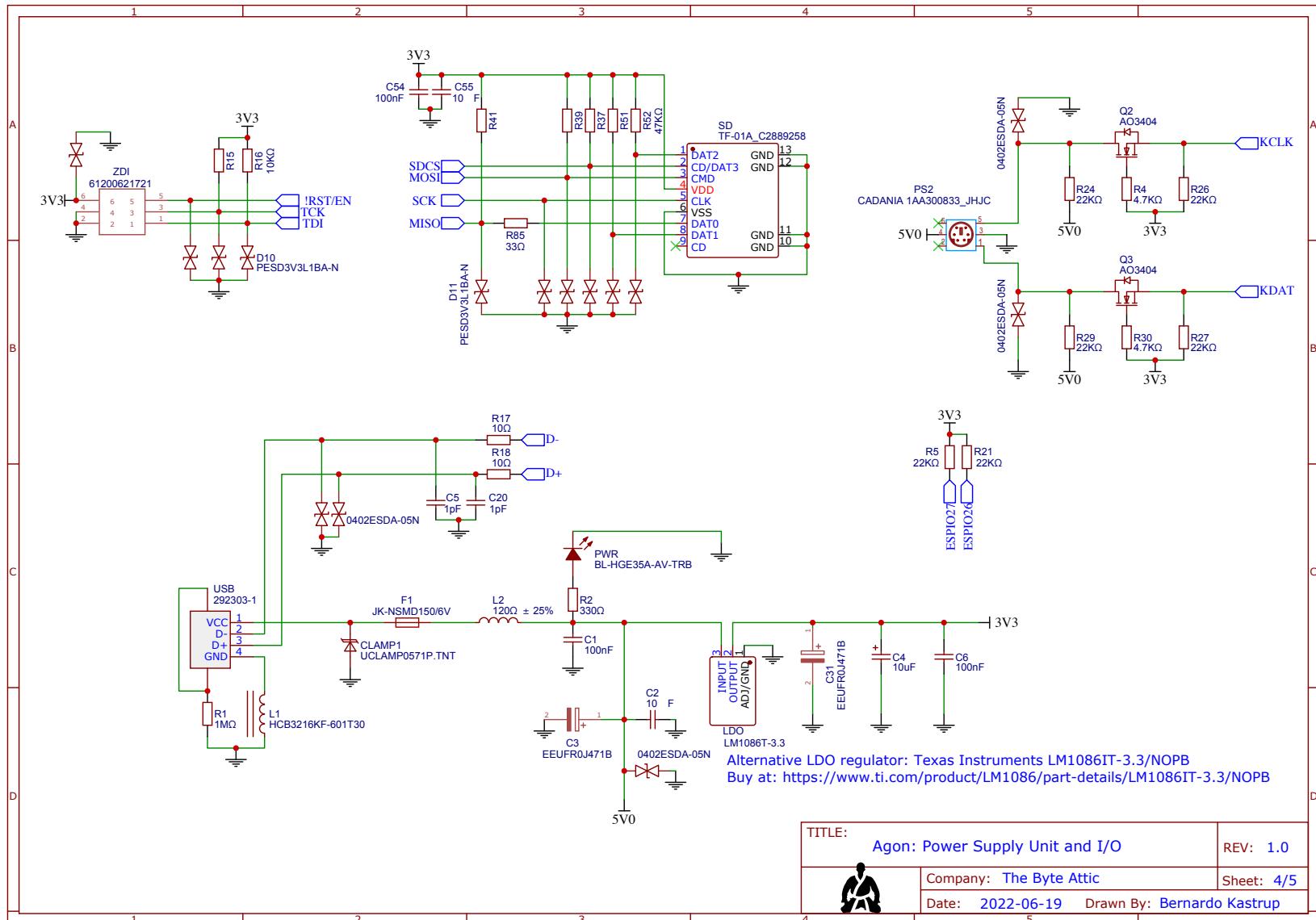
The Byte Attic's
Agon
light™
Schematics

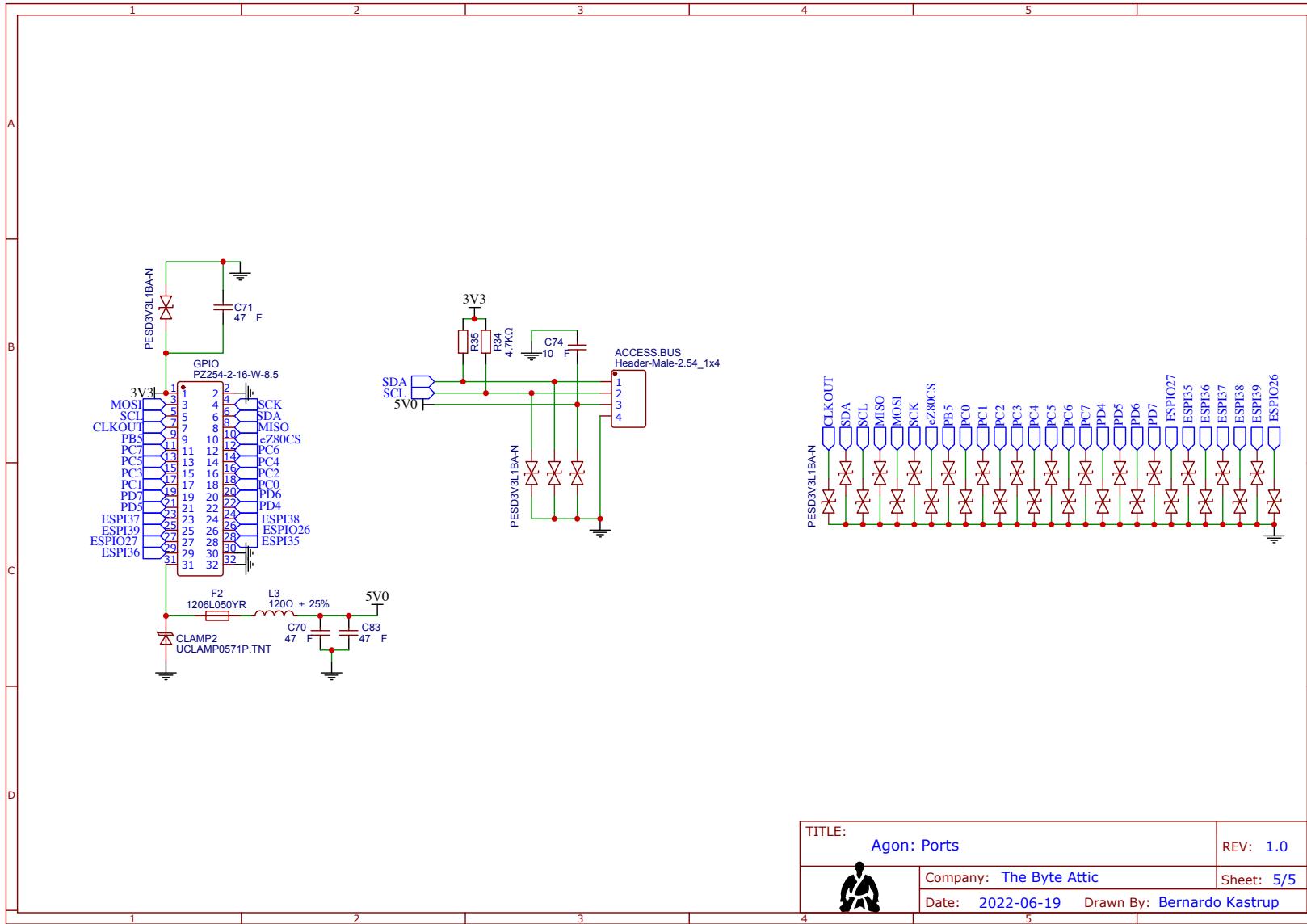










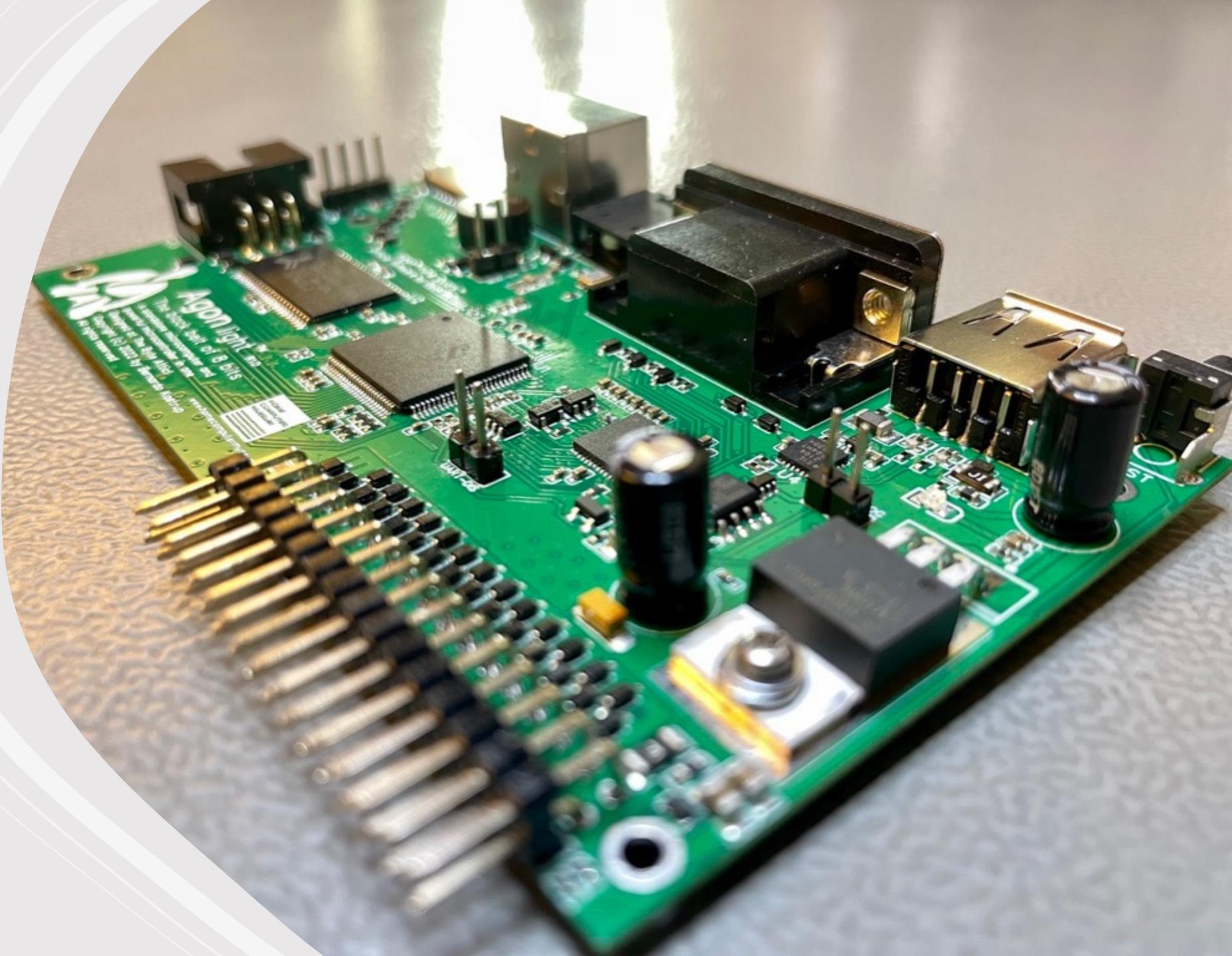




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Agon light™

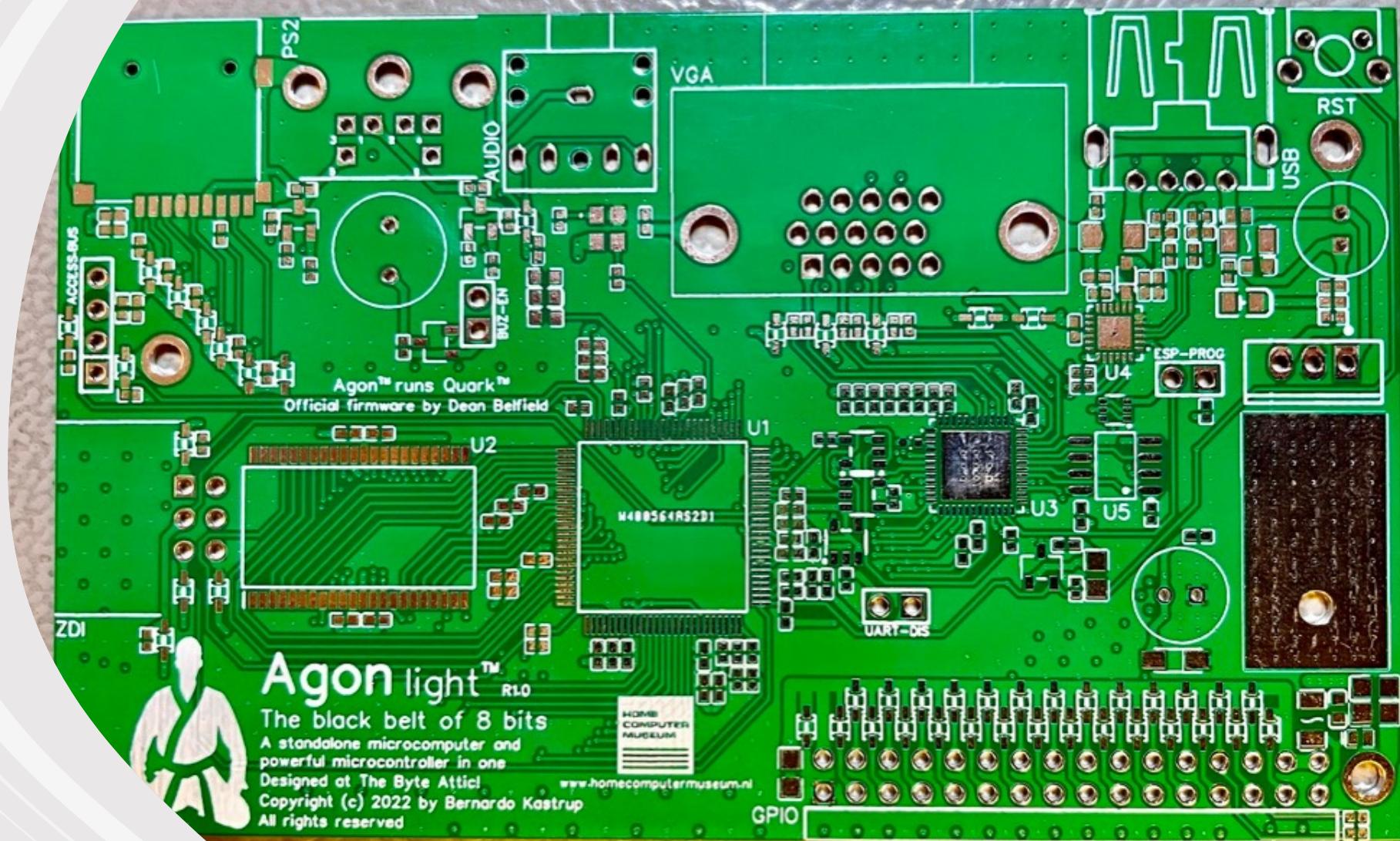
Bill of
Materials



ID	Name	Designator	Footprint	Quantity	Manufacturer Part	Manufacturer	Supplier	Supplier Part	Price	
1	B047BUTIG	Q4	SOT-23-3_L2.9-W1.6-P1.90-L52-8-BR	1	BC847BL17G	ON	LSC	C4393	0.035	
2	R28	R28	R0402	1	0402WGF2001CE	Unidom	LSC	C4109	0.001	
3	A5E-18.432MHz-LC-T	OSC	A5E18432MHZLCLCT	1	A5E18433MHZ-LC-T	ABRACON	Mouser	815-A5E18.432MHZLCLCT	0.384	
4	A5T34096A-10TCN	U2	SOP8PBP118X12044N	1	A5T34096A-10TCN	Aluratek	Mouser	913-A5T34096A-10TCN	0.043	
5	PZ256-2.16-W-8.5	GPIO	HOB-TH-32P-2.54-1144-82-CHS-52-54	1	PZ256-2.16-W-8.5	NETL(华晶美)	LSC	C284956	0.049	
6	Header-Male-2.54_1x4	ACCESS_BUS	HOB-TH-32P-2.54-1144-82-CHS-52-54	1	4P_L=1.0MM_GND+P	Centow	LSC	C14378	0.049	
7	PJ-307C	AUDIO	AUDIO-TL_P1307C	1	PJ-307C	BOOMLE	LSC	C16684	0.043	
8	22-28-4020	BIZ-EN-ESP-PROG-UART-DIS	HOB-TH-3P-2.54-V.M-1	3	22-28-4020	MOLEX	LSC	C234182	0.076	
9	CMT-9648-85T	BUZZER	CMT964885T	1	CMT964885T	TE Connectivity	LSC	C86461	0.407	
10	10nf	C8/C9/C10/C11/C16/C18/C25/C27/C8/C9/C10/C11/C16/C18/C25/C27/C8/C9/C10/C11/C16/C18/C25/C27/C8/C9/C10/C11/C16/C18/C25/C27	C0402_NEW	23	CLO5B10405NNINC	SAMSUNG	LSC	C1525	0.001	
11	10pF	C0402	C0402	20	CLO5A106M050NUINC	SAMSUNG	LSC	C15525	0.005	
12	1pF	C0402	C0402	2	0402GG3100C50NT	FH	LSC	C1550	0.001	
13	4.7μF	C0402	C0402	2	CLO5A475UMPNINC	SAMSUNG	LSC	C27733	0.006	
14	10nf	C13	C0402	8	CLO510313MB500NT	SAMSUNG	LSC	C1595	0.001	
15	1nF	C0402	C0402	1	CLO5A105050NNINC	SAMSUNG	LSC	C1523	0.003	
16	1uf	C0402	C0402	1	CLO5A2150105050NT	Panasonic	LSC	C29266	0.003	
17	ELUF10471B	C3-C11	CAP-SMD-13.2-W1.6-R-RD	1	ELU-FR0471B	EU-FR0471B	LSC	C7171	0.098	
18	10uf	C4	CAP-SMD-13.2-W1.6-R-RD	1	TAJA06061BNJ	AIXX	LSC	C21117	0.006	
19	33nF	C3	C0003	1	CL10033MB88NNINC	SAMSUNG	LSC	C28333	0.009	
20	1uf	C53	C0005	3	CL2105GBPNINNE	SAMSUNG	LSC	C16780	0.026	
21	47uF	C70-C17-C13	C0005	2	UGLAMPS572P1NT	SEATECH	LSC	C51287	0.403	
22	UC1AM985712-TNT	CLAMP-DIODE	SGP1650N12A-0.9-01-RD	1	IN4148W514	C	LSC	C2128	0.013	
23	IN4148W514	D1	SOD-323_L1.8-W1.3-L5.2-RD	1	SOD-323_L1.8-W1.3-L5.2-RD	PESD3V31BA-N	Bourne Semicon (Shenzhen)	LSC	C346020	0.051
24	PESD3V31BA-N	D1	SOD-323_L1.8-W1.3-L5.2-RD	1	PESD3V31BA-N	Bourne Semicon (Shenzhen)	LSC	C346020	0.051	
25	E5D3	DB	DB0402-BI	1	0402LS04-05N	Bourne Semicon (Shenzhen)	LSC	C316049	0.019	
26	0402ESD-PROT-LED	D88-ESD-LED-PROT-LED-PROT2-SDP-PROT3	DB0402-BI	5	0402LS04-05N	Bourne Semicon (Shenzhen)	LSC	C316049	0.019	
27	JK-15M015D1506V	F1	F1306	1	JK-15M015D1506V	JK(金科)	LSC	C280249	0.036	
28	1206050YR	F2	F1306	1	1206050YR	Uitec	LSC	C163512	0.065	
29	IC03216MF-601730	L1	F1306	1	HE3216MF-601730	TAITEC	LSC	C37023	0.028	
30	120nf ±25%	L1,L3	F1306	2	BLUM18KG121TN10	Multata	LSC	C88811	0.017	
31	3.1nH	L1	IND-SMD-12.2-W0.6	2	BLUM18KG121TN10	Abracon LLC	LSC	C188816	0.224	
32	UM10867-3.3	LDO	TO-220-3_L10-W4.5-P2.54L	1	UM10867-3.3	HSSEM	C Directec, I	C44431	0.241	
33	CADANIA_JAK30833_JHJC	PS2	PS2-PORT	1	BL-HGE55A-AV-TB	Bright LED Elec.	LSC	C165984	0.047	
34	BL-HGE33A-AV-TB	PWR	LEDO805-0-RD	1	UM3B3	LG	LSC	C52892	0.049	
35	UM83N	Q1	SC70-6_12.2-W1.3-P1.90-L5.2-1-BR	2	AQ2304	Gumtong Intech	LSC	C192925	0.001	
36	A03404	Q2-0.03	SOT-23-3_L2.9-W1.6-P1.90-L5.2-4-BR	1	0402WGF10MTC	Unidom	LSC	C26983	0.001	
37	1.8MΩ	R1	R0402	1	0402WGF10MTC	Unidom	LSC	C21024	0.001	
38	3.8Ω	R2	R0402	1	0402WGF1002CE	Unidom	LSC	C2744	0.001	
39	10KΩ	R3,R4,R5,R6,R7,R8,R9,R10,R11	R0402	9	0402WGF1002CE	Unidom	LSC	C25077	0.001	
40	4.7KΩ	R11,R12,R13,R14,R15,R16,R17,R18,R19,R20	R0402	10	0402WGF4701CE	Unidom	LSC	C25900	0.001	
41	2KΩ	R21,R22,R23,R24,R25	R0402	6	0402WGF4701CE	Unidom	LSC	C27948	0.001	
42	47KΩ	R6,7	R0402	2	0402WGF4701CE	Unidom	LSC	C25117	0.001	
43	40Ω	R8,R12,R13	R0402	3	PTFF04024024BKN9	RES(研华)香港	LSC	C262862	0.079	
44	80Ω	R9,R10,R11	R0402	3	TC0228B86007CE	Uniroyal Elec	LSC	C150511	0.061	
45	100	R12,R13	R0402	2	0402WGF1001CE	Unidom	LSC	C25077	0.001	
46	33Ω	R31,R32,R33,R34,R35,R36,R37,R38,R39,R40,R41	R0402	12	0402WGF3301CE	Unidom	LSC	C25105	0.001	
47	47KΩ	R37,R39,R41,R42,R52	R0402	5	0402WGF4701CE	Unidom	LSC	C27942	0.001	
49	150Ω	R22	R0603	1	0603WAF15005E	Unidom	LSC	C22966	0.002	
50	TF-01A_CZB891258	SD	TF-01A	1	TF-01A	Vland(台湾元通)	LSC	C28208	0.002	
51	EZ0809342402DEG	U1	QFP55PQFP55QFN160X160	1	EZ0809342402DEG	Zilog	LSC	C288937	0.088	
52	ESP32-F00-D4	U3	QFN-44_L7D-W7-D4-P0-30-BLEP2.6	1	ESP32-F00-D4	Espresso Systems	LSC	C193707	3.82	
53	CP2104-F03-GMR	U4	QFN-44_L7D-W7-D4-P0-30-BLEP2.6	1	CP2104-F03-GMR	SILICON LABS	LSC	C47015	2.361	
54	AP5640L-350	U5	SOT-23-3_L2.9-W1.6-P1.90-L5.2-8-BR	1	AP5640L-350-5N	Diodes Incorporated	LSC	C143831	0.059	
55	AP5640S-35A-7	U6	SOT-23-5_L3_W1.7-P1.90-L5.2-8-BR	2	AP5640S-35A-7	Diodes Incorporated	LSC	C29554	0.087	
56	SNT4UICIG1250BVR	U7,U8	SOT-23-5_L3_W1.7-P1.90-L5.2-8-BR	1	SNT4UICIG1250BVR	TI	LSC	C7827	0.112	
57	SNT4UICIG040BVR	U9	SOT-23-5_L3_W1.7-P1.90-L5.2-8-BR	1	SNT4UICIG040BVR	TE Connectivity	LSC	C86461	0.407	
58	U77HDF1550DCHARRINGVA	U10	U77HDF1550DCHARRINGVA	1	U77HDF1550DCHARRINGVA	SHORBY	LSC	C499319	0.062	
59	222303-1	U11	613006217211	1	TS-1093A-A12B3-D2	Vland	LSC	C499319	0.062	
61	TS-1093A-A12B3-D2	RST	KEY-TI_4P_L7.1-W12-A4_P4_S01_L5.2	1	TS-1093A-A12B3-D2	Vland	LSC	C499319	0.062	



The Byte Attic's
Agon
light™
PCB

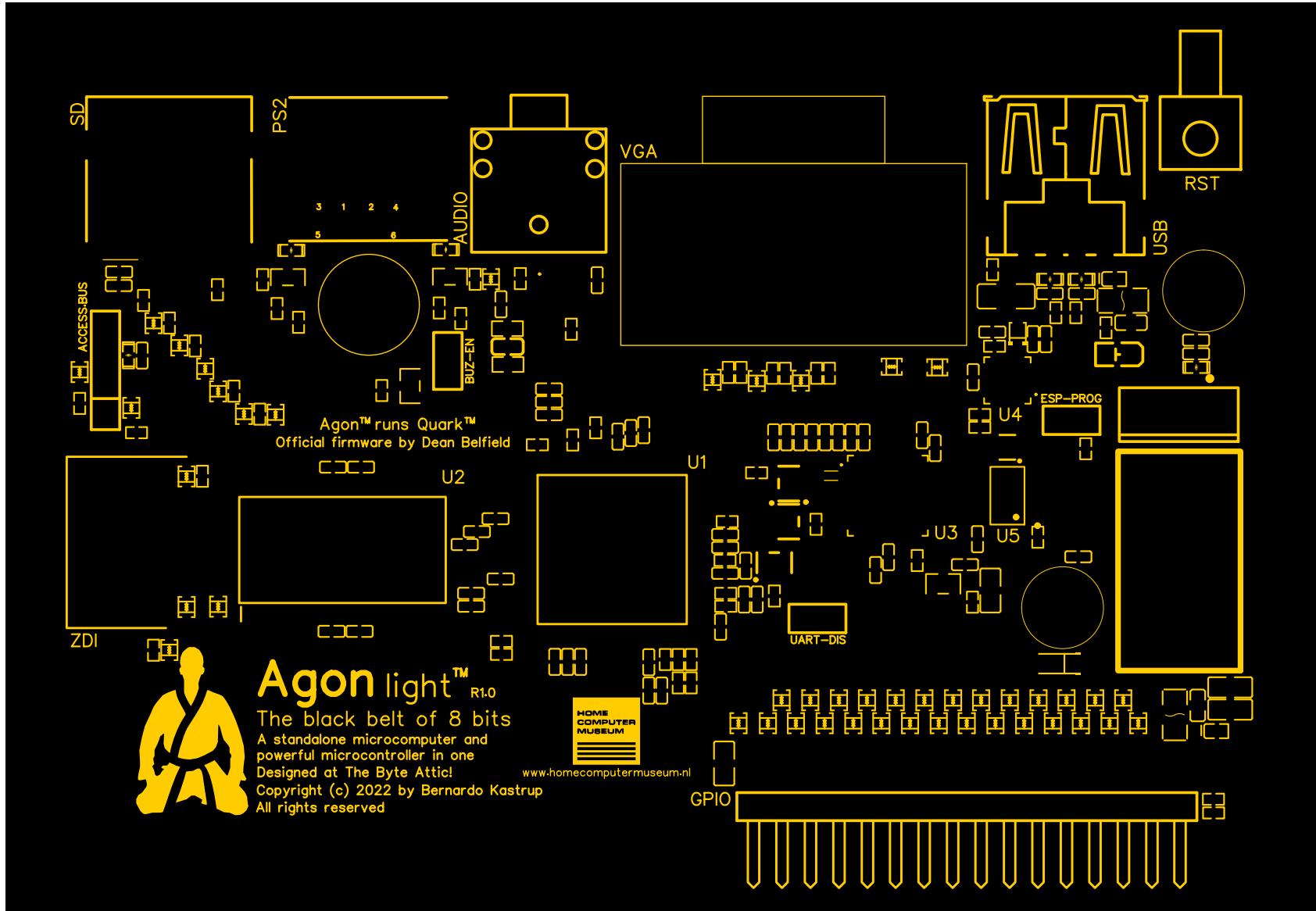


PCB dimensions (diagram *not* to scale)

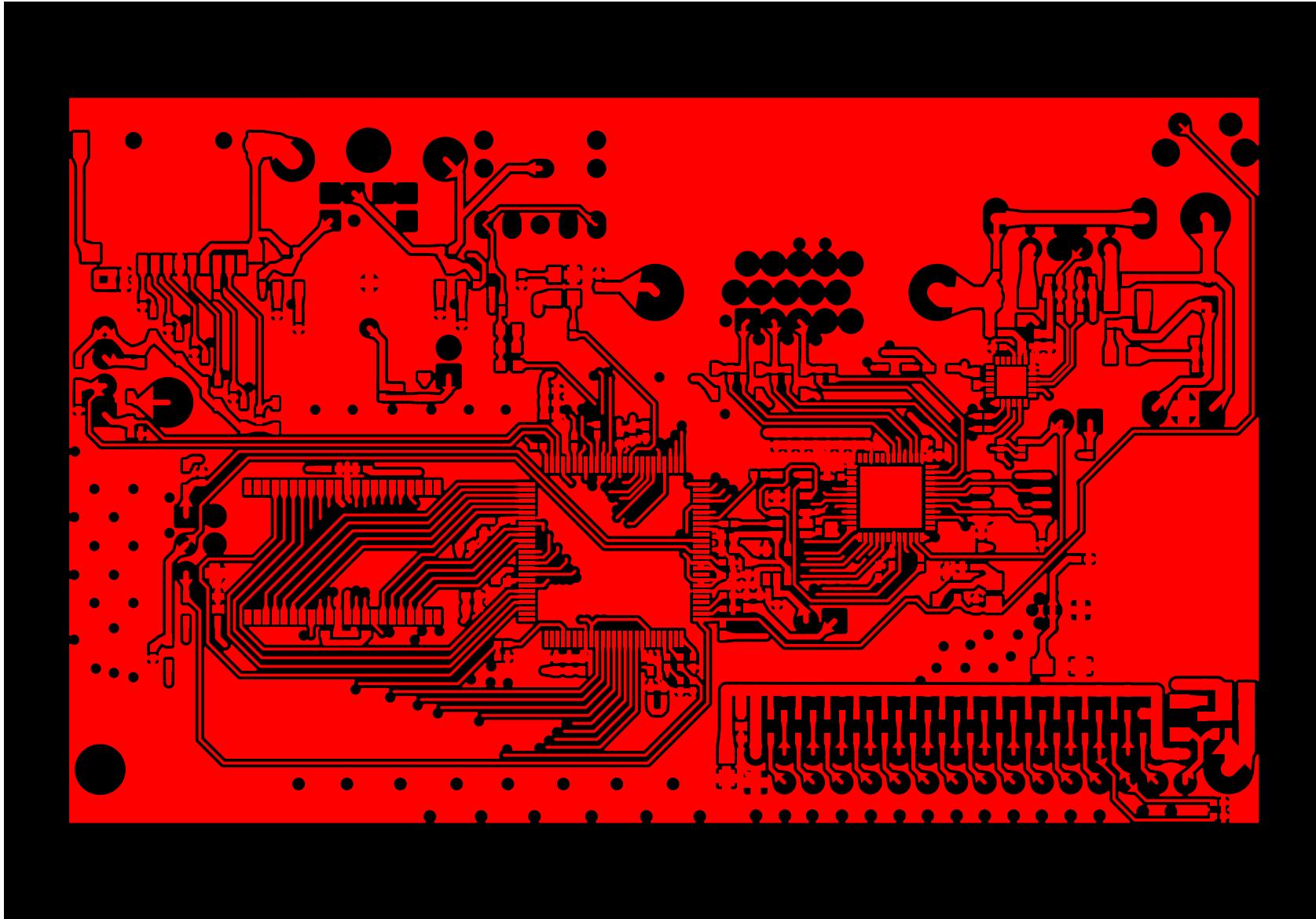


All holes
are
2.505mm
in
diameter

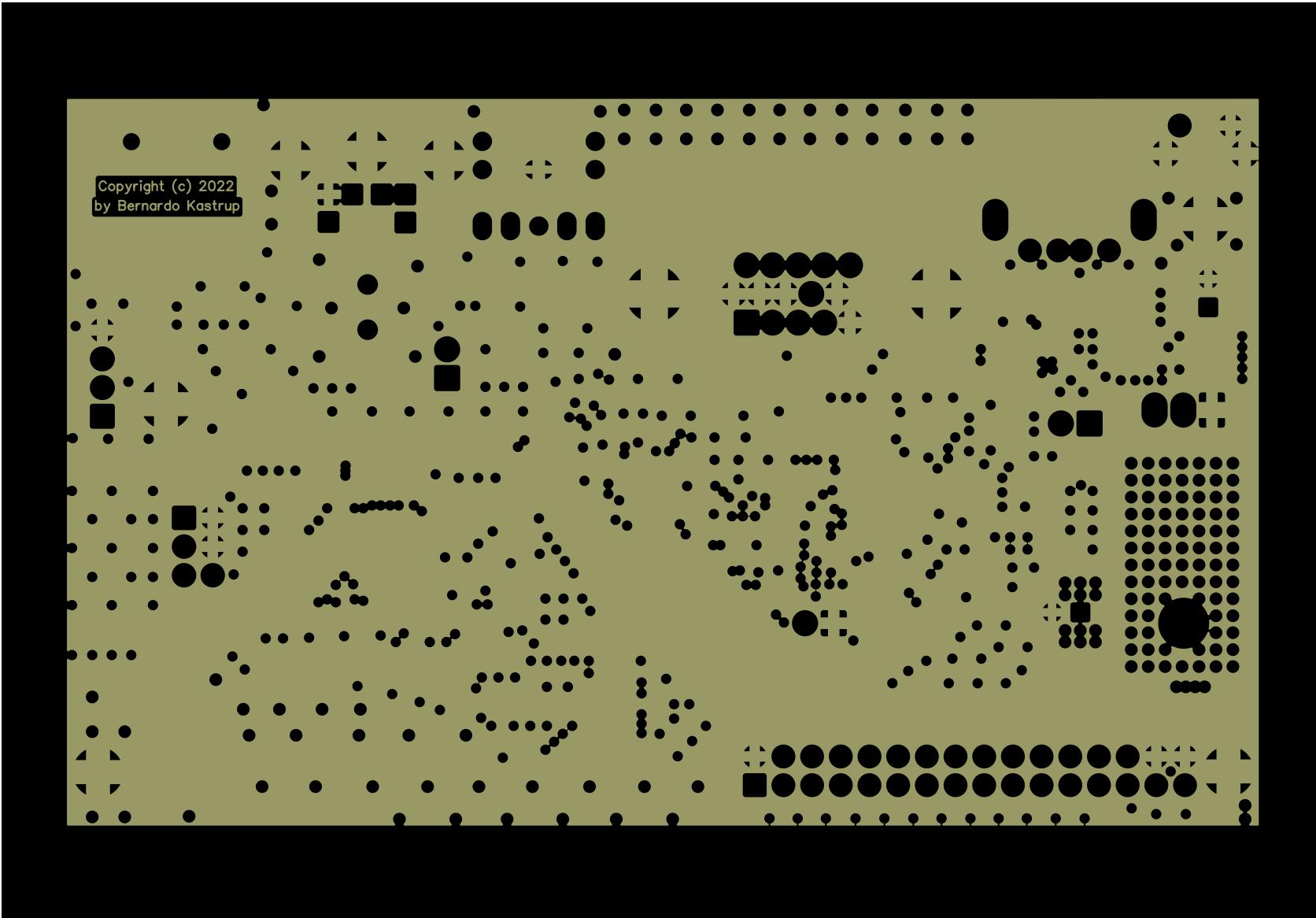
Top silkscreen



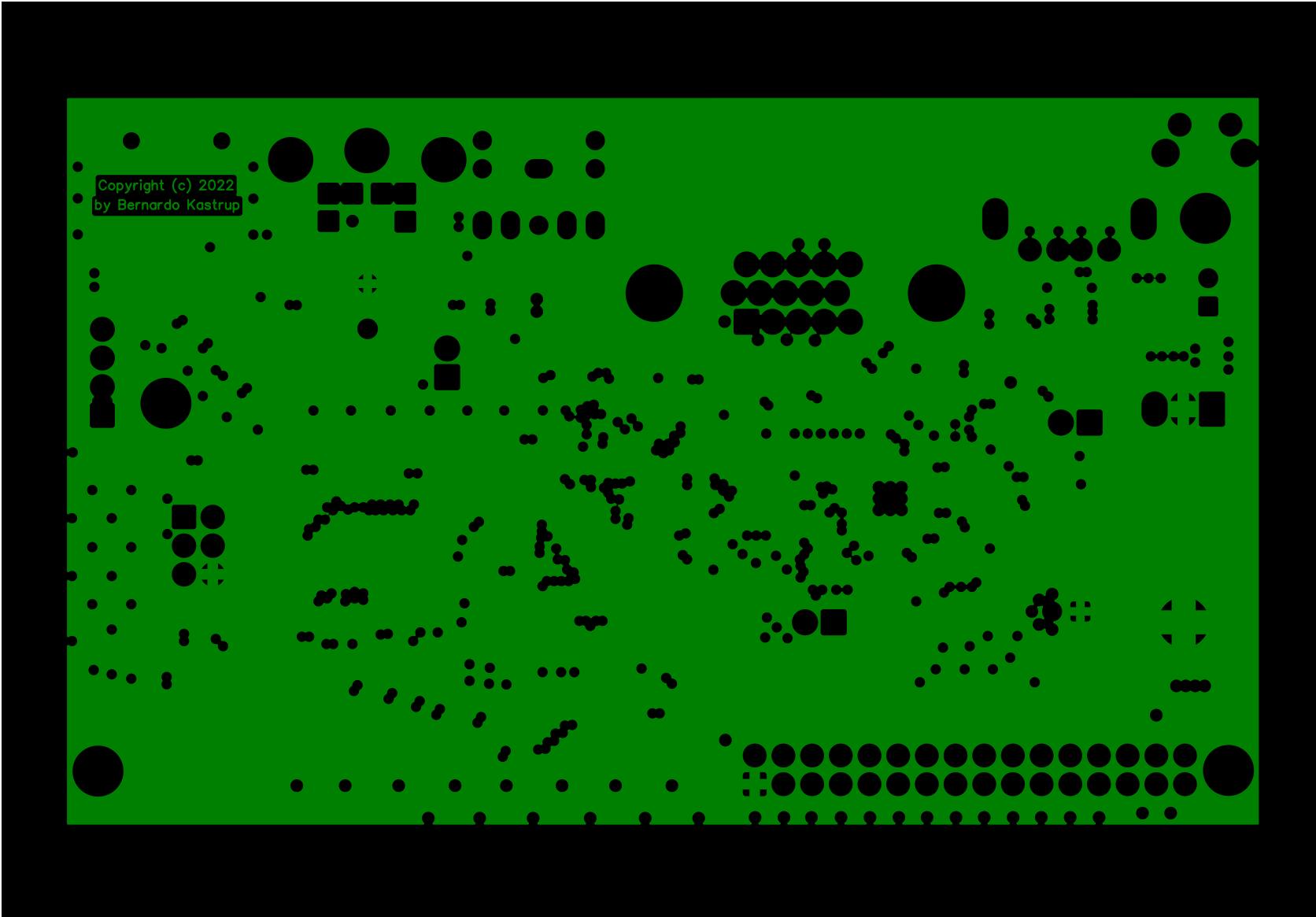
Top metal layer (3.3V filled)



First inner plane (GND)



Second inner plane (3.3V)



Bottom metal layer (GND filled)

